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Ziegler et al.

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(54) **RADIATION DETECTING WEARABLE DEVICES**

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(*) Notice: Subject to any disclaimer, the term of this patent is extended or adjusted under 35 U.S.C. 154(b) by 0 days.

This patent is subject to a terminal disclaimer.

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G01N 27/00 (2006.01)
G01N 23/10 (2006.01)
(Continued)

(52) **U.S. Cl.**
CPC **G01N 23/10** (2013.01); **G01T 1/026** (2013.01); **H01L 31/085** (2013.01); **G01N 2223/501** (2013.01); **G01N 2223/6126** (2013.01)

(58) **Field of Classification Search**

CPC **G01N 33/0031**; **G01N 33/0032**; **G01N 23/00**; **G01N 23/08**; **G01T 1/16**; **G01T 1/24**; **G01T 1/241**; **G01T 1/243**
(Continued)

(56) **References Cited**

U.S. PATENT DOCUMENTS

5,256,879 A * 10/1993 McNulty **G01T 1/247**
250/370.06
5,596,199 A 1/1997 McNulty et al.
(Continued)

OTHER PUBLICATIONS

Davis et al., "Tissue equivalency of diamond for proton and alpha particles typical of Galactic Cosmic Rays", 2012.

(Continued)

Primary Examiner — Jill Warden

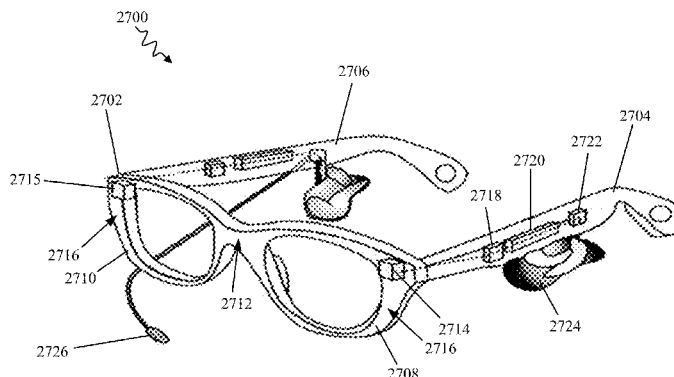
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Razmig H. Messerian

(57) **ABSTRACT**

One feature pertains to a microdosimeter cell array that includes a plurality of microdosimeter cells each having a semiconductor volume adapted to generate a current in response to incident radiation. The semiconductor volumes of each of the plurality of microdosimeter cells have at least one of a size, a shape, a semiconductor type, and/or a semiconductor doping type and concentration that is associated with one or more cells or cell components of a human eye. A processing circuit is also communicatively coupled to the microdosimeter cell array and generates a signal based on the currents generated by the semiconductor volumes of the plurality of microdosimeter cells. The signal generated by the processing circuit is indicative of an amount of radiation absorbed by the microdosimeter cell array.

20 Claims, 28 Drawing Sheets



Related U.S. Application Data

continuation of application No. 13/959,616, filed on Aug. 5, 2013, now Pat. No. 8,858,888.

- (60) Provisional application No. 61/739,580, filed on Dec. 19, 2012, provisional application No. 62/034,709, filed on Aug. 7, 2014.

- (51) **Int. Cl.**

H01L 31/08 (2006.01)

G01T 1/02 (2006.01)

- (58) **Field of Classification Search**

USPC 250/370.01, 370.07; 422/98, 502
See application file for complete search history.

- (56) **References Cited**

U.S. PATENT DOCUMENTS

6,278,117	B1	8/2001	Bardash
7,500,746	B1	3/2009	Howell et al.
8,350,225	B1	1/2013	Bardash
8,421,022	B2	4/2013	Rozenfeld

8,858,888	B2 *	10/2014	Ziegler		G01N 23/00
					250/370.01
2005/0106713	A1 *	5/2005	Phan		B01L 3/502738
					435/287.2

2006/0027756	A1	2/2006	Thomson et al.
2010/0090118	A1	4/2010	Rozenfeld

OTHER PUBLICATIONS

Livingstone et al., "Comparison of Epitaxial and SOI based Large Area Microdosimeters", Submitted to 2011 IEEE Nuclear Science Symposium and Medical Imaging Conference, Valencia, Spain, Oct. 23-29, 2011.(to be published in Engineering and Physical Sciences in Medicine (ESPM).

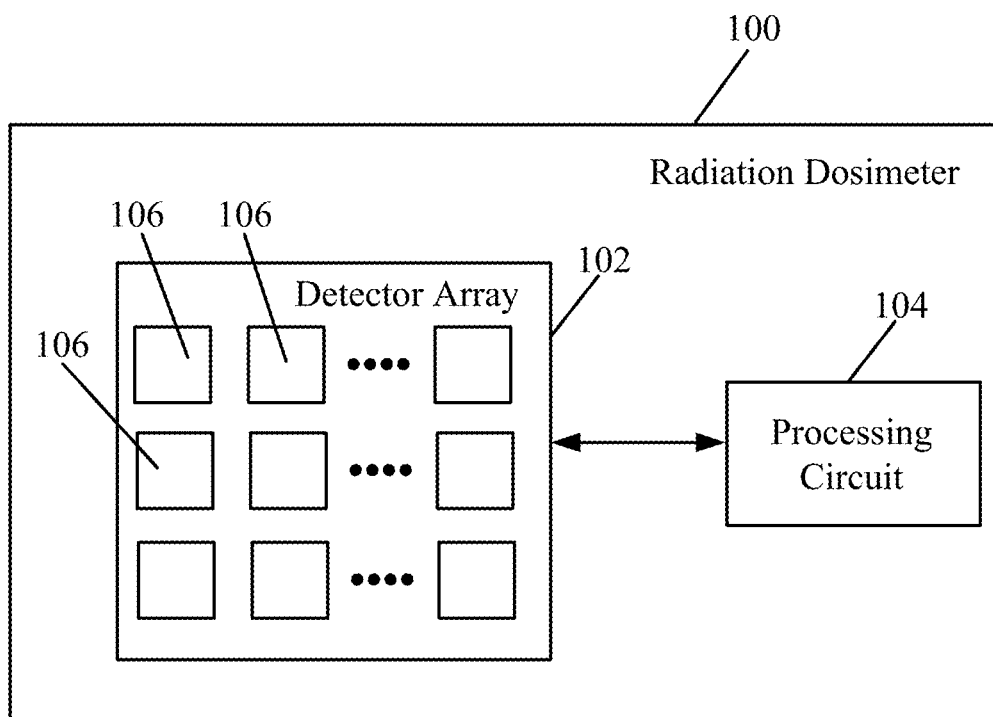
Prokopovich et al., "Comparison of SOI Microdosimeter and Tissue Equivalent Proportional Counter Measurements at the CERF Facility", IEEE Trans. on Nucl. Sci., NS-59, 2351-2354, 2012.

Rosenfeld, "Advanced Semiconductor Dosimetry in Radiation Therapy", AIP Conference Proceedings, vol. 1345, "Concepts and Trends in Medical Radiation Dosimetry", 2011.

Van Dam et al., "ESTRO Booklet on Physics for Clinical Radiotherapy No. 1", (Garant, Leuven-Apeldoorn, 1994).

Ziegler et al., "SRIM—The Stopping and Range of Ions in Matter (2010)", Nuclear Inst. and Meth., vol. B-268, 1818-1823 (2010).

* cited by examiner

***FIG. 1***

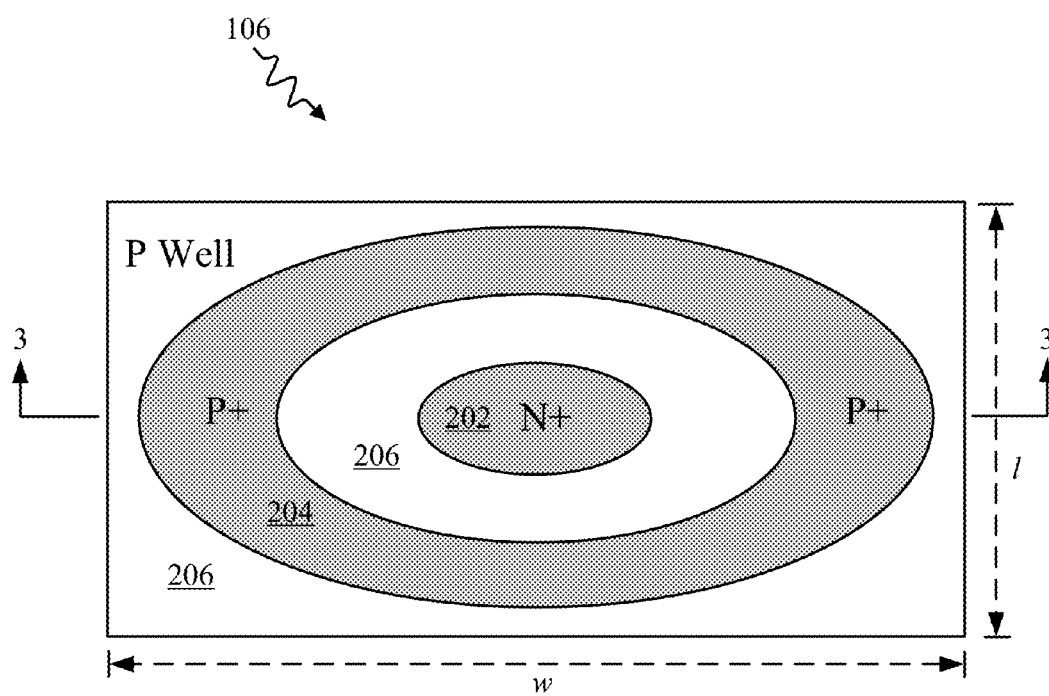


FIG. 2

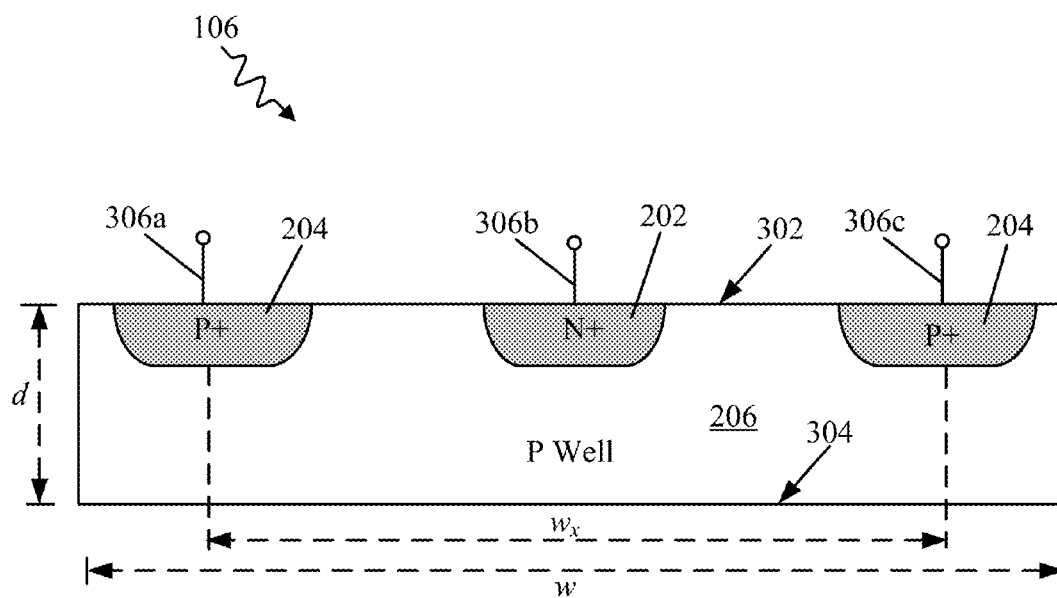


FIG. 3

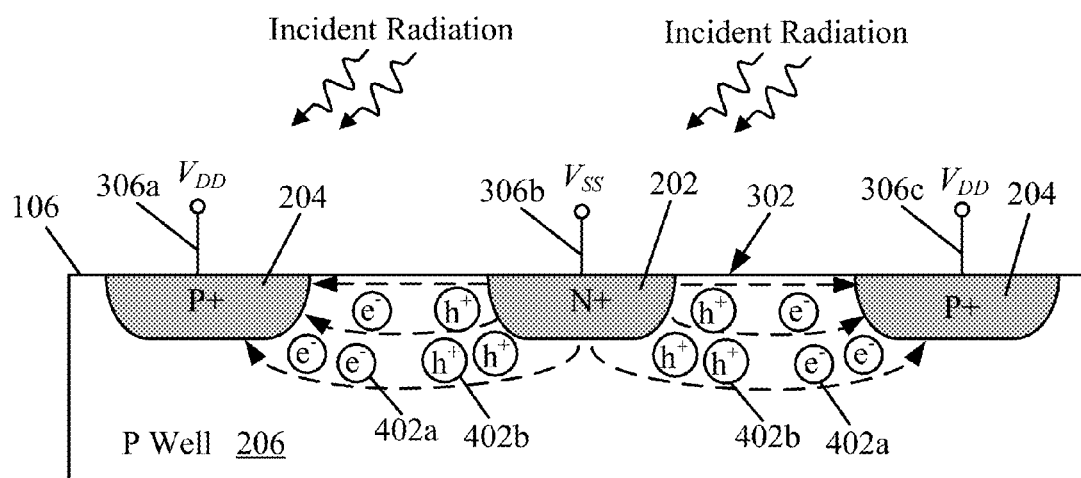
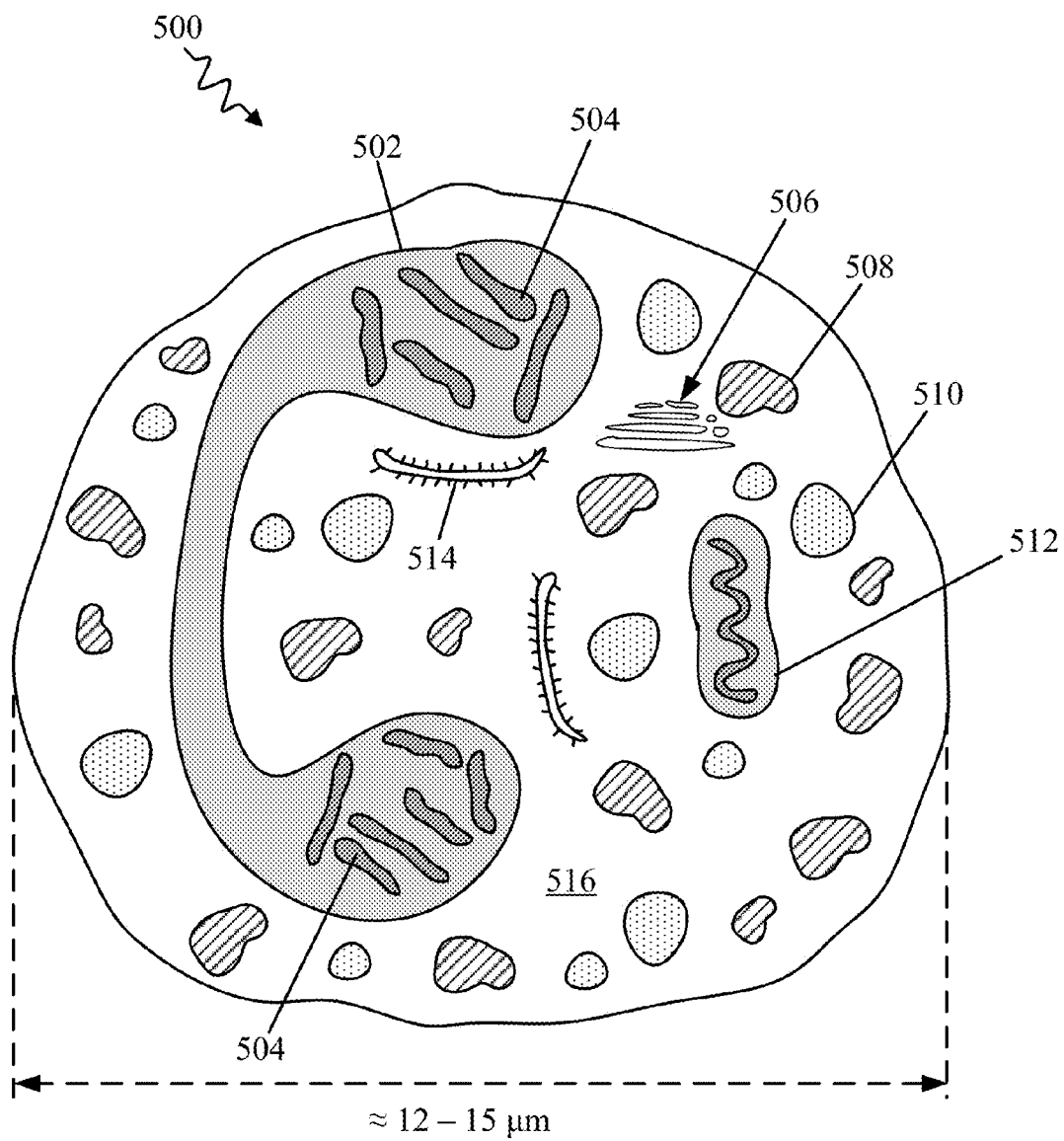


FIG. 4

**FIG. 5**

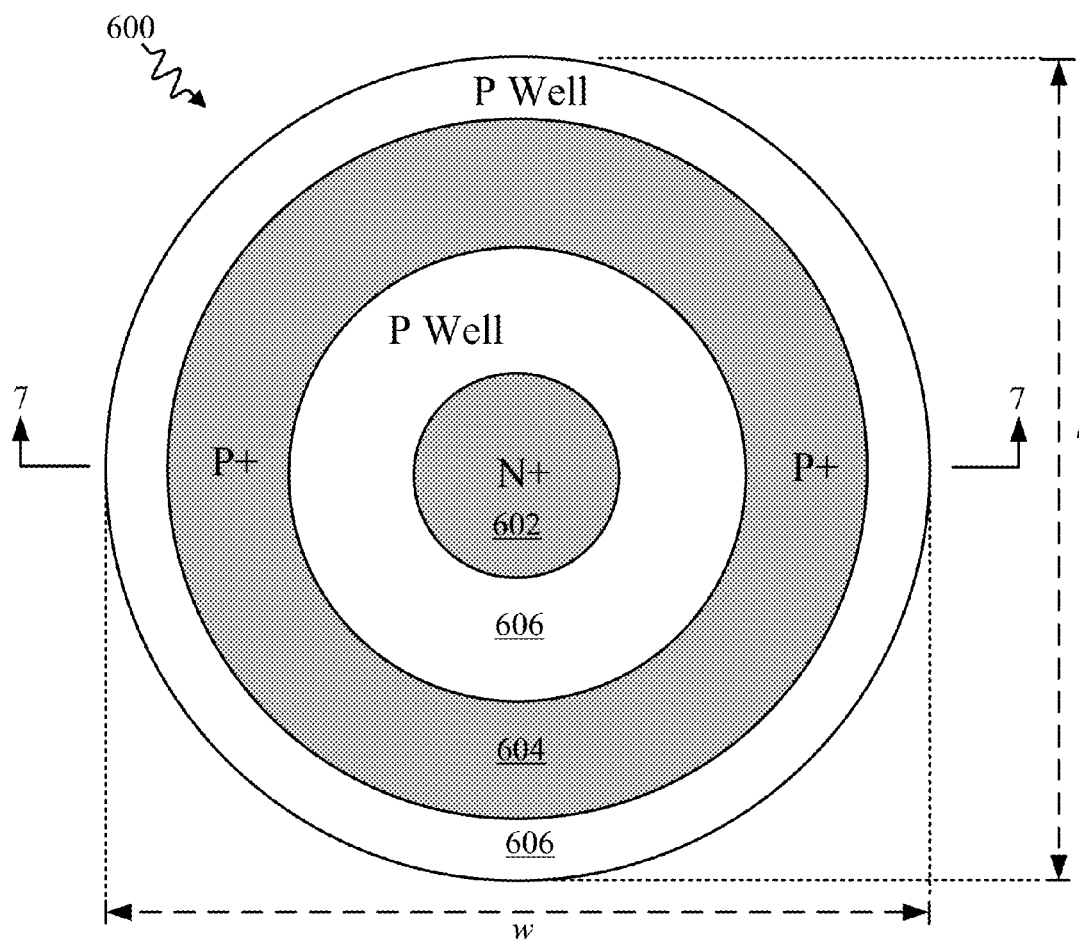


FIG. 6

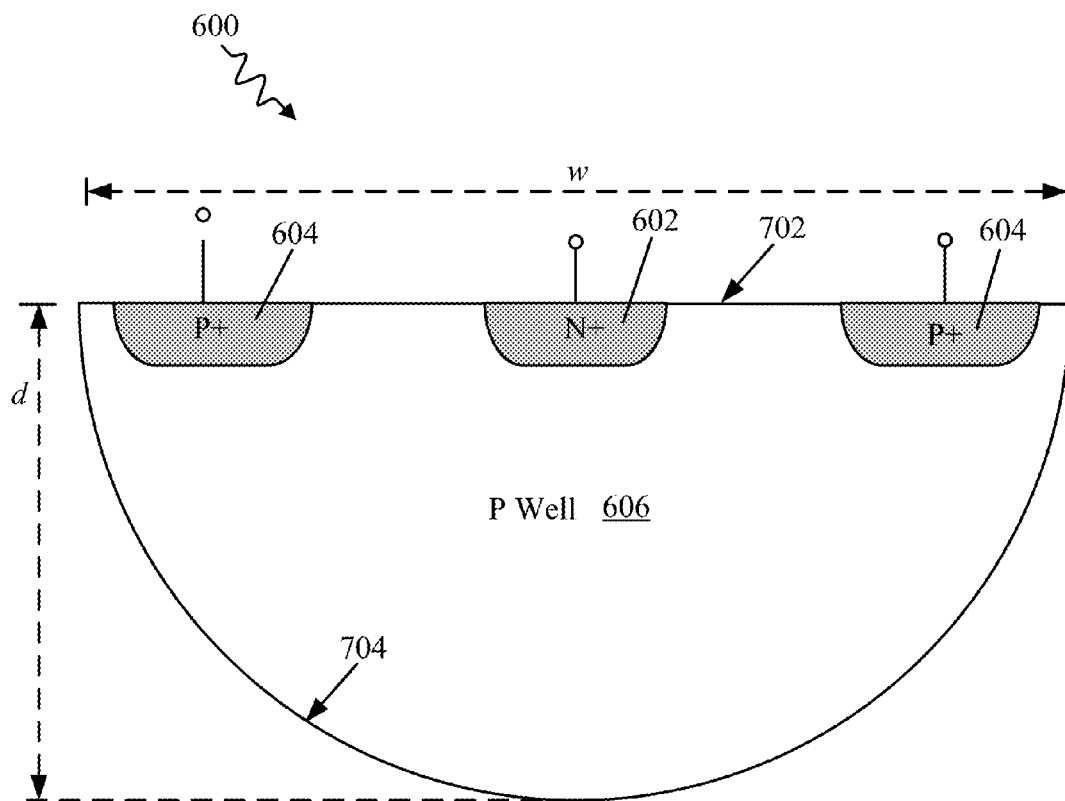
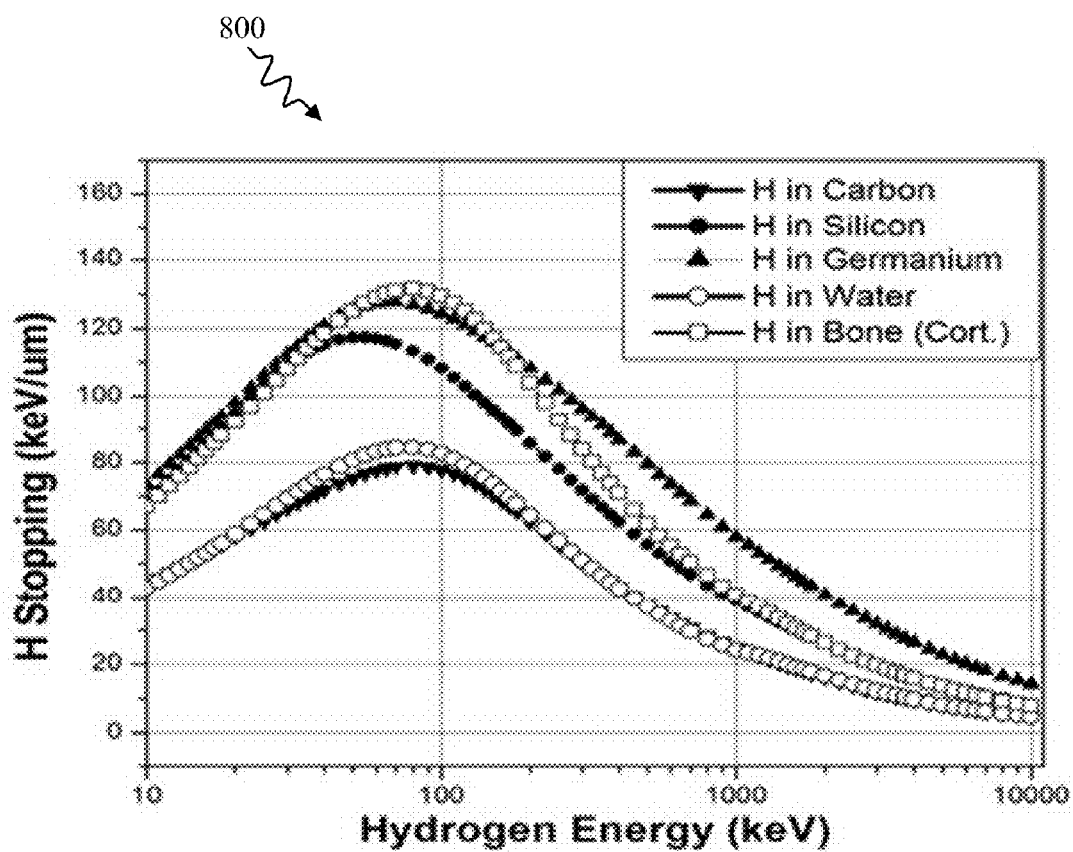
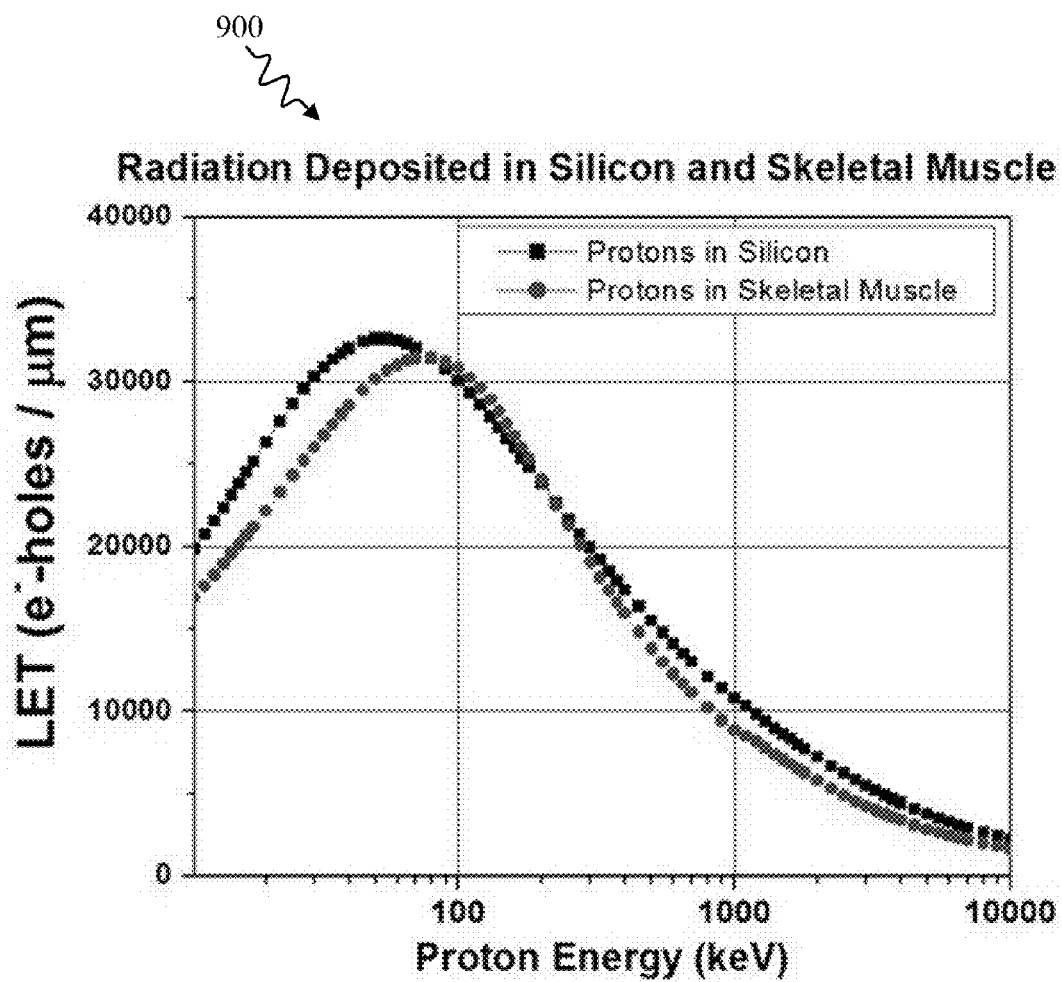
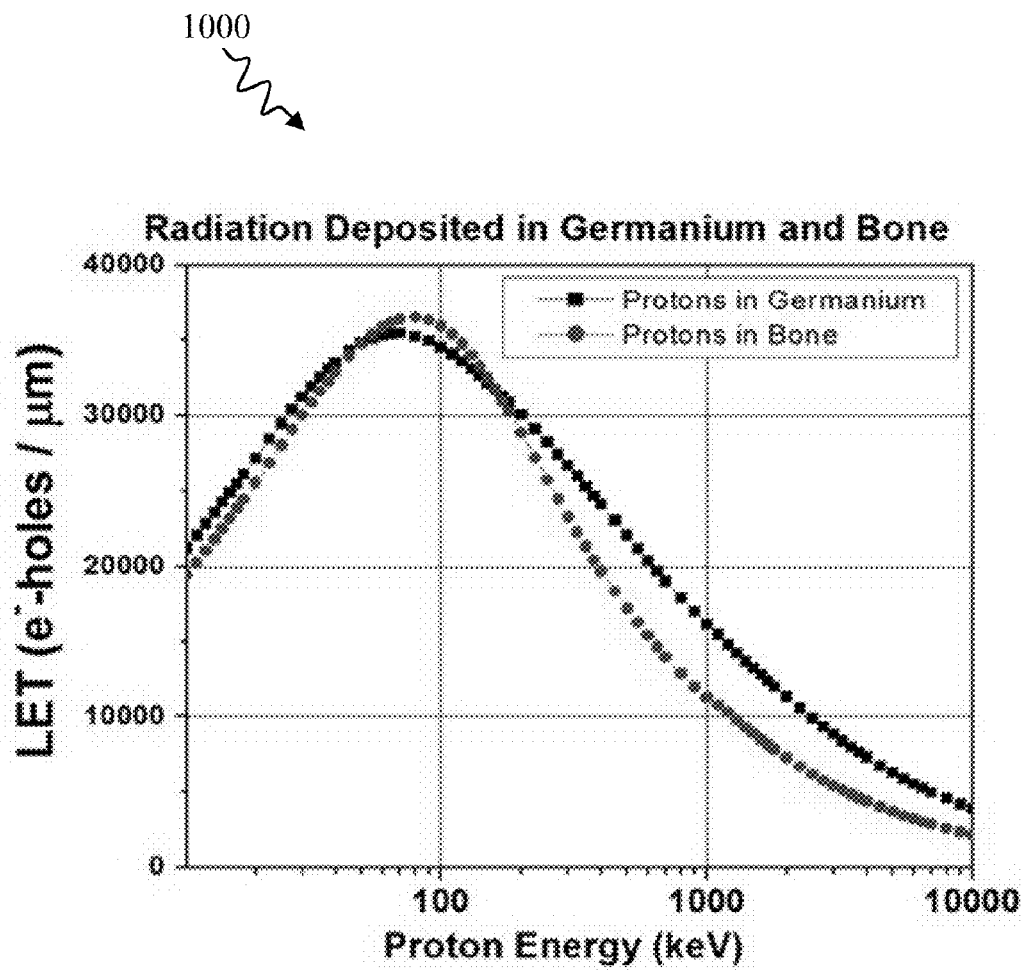


FIG. 7

**FIG. 8**

**FIG. 9**

**FIG. 10**

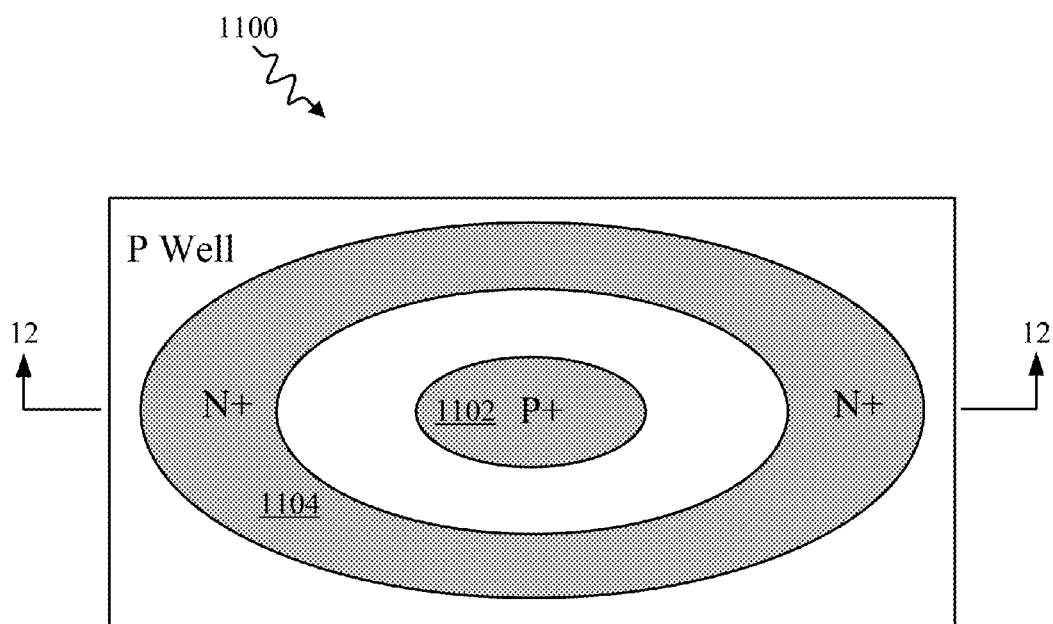
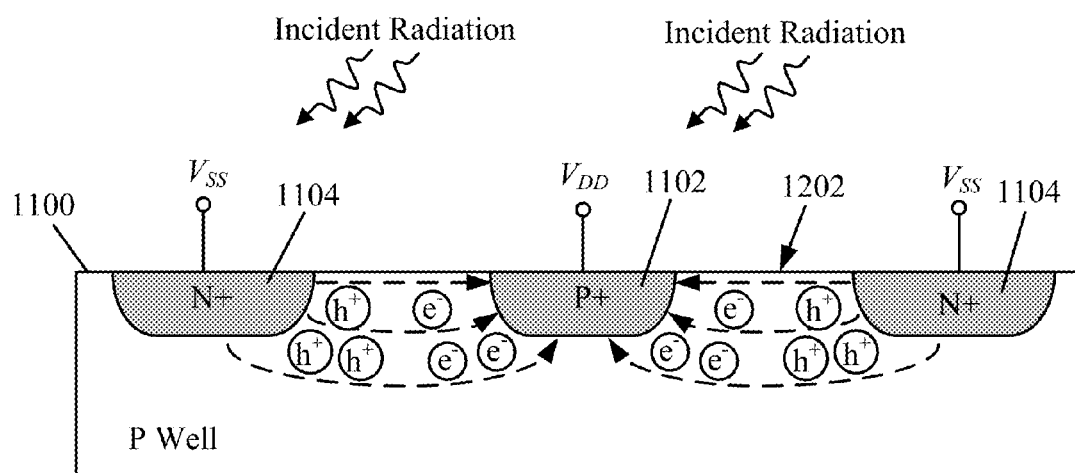


FIG. 11

**FIG. 12**

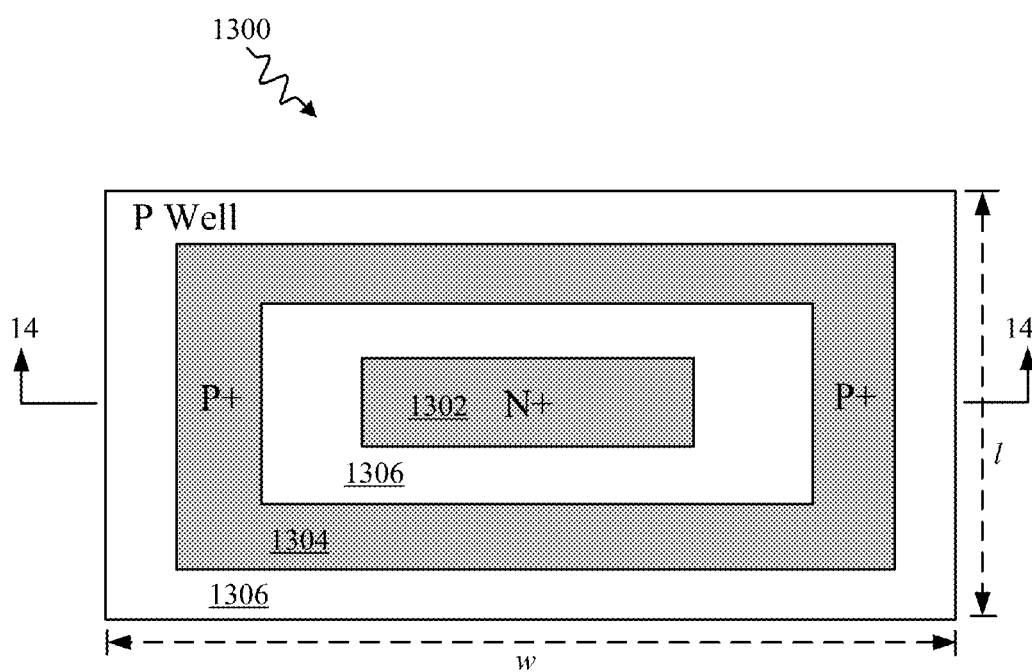
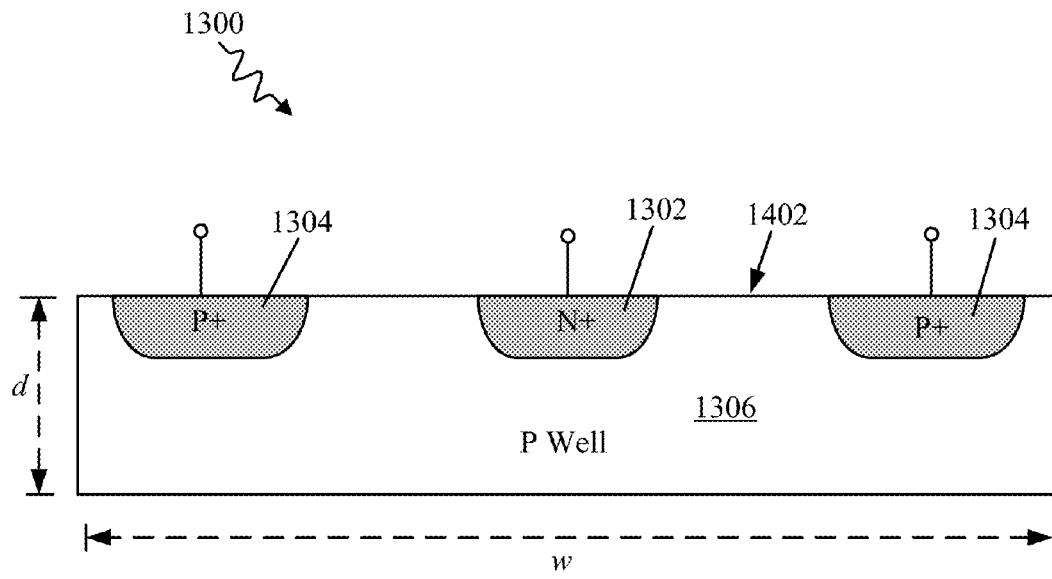


FIG. 13

**FIG. 14**

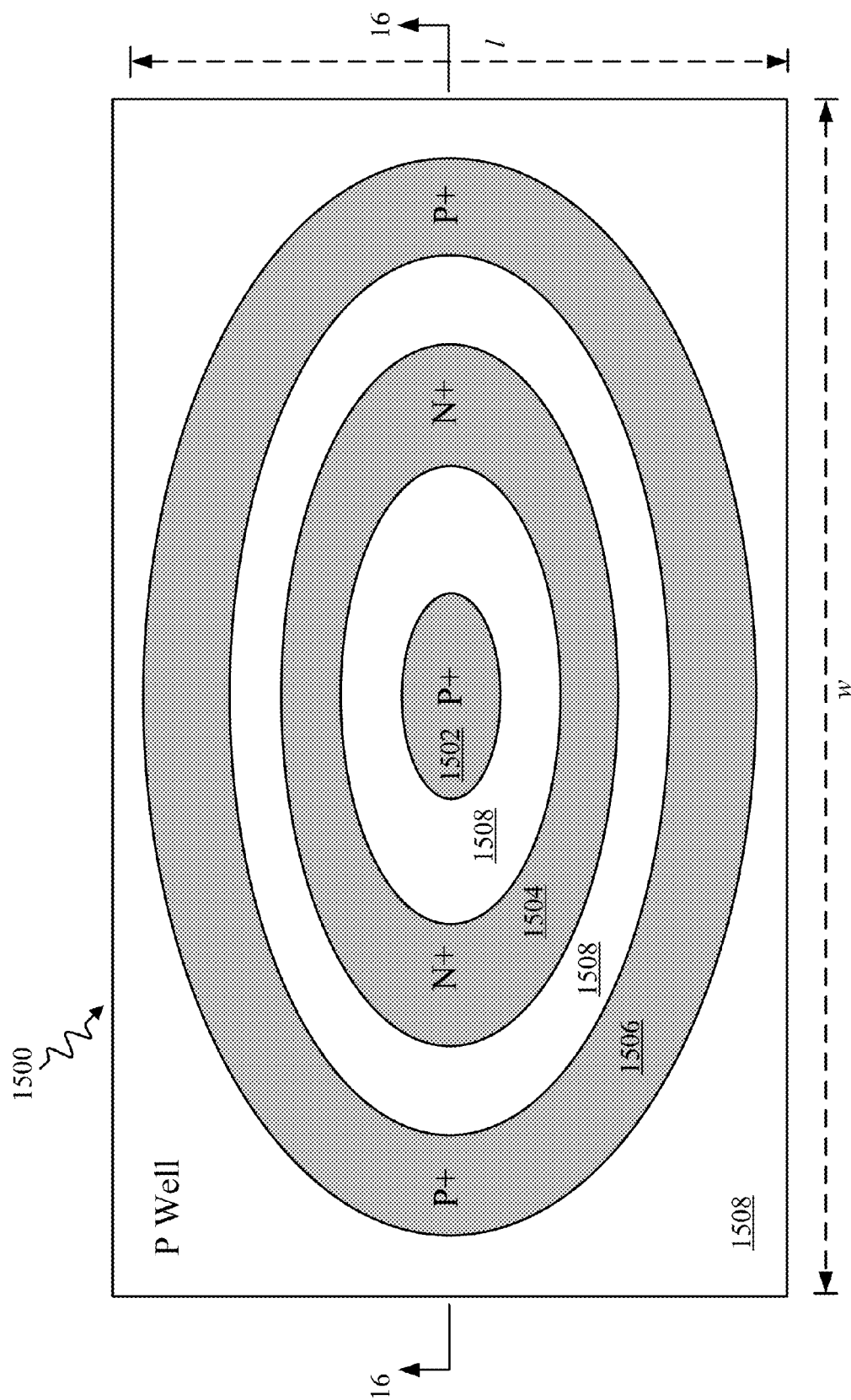


FIG. 15

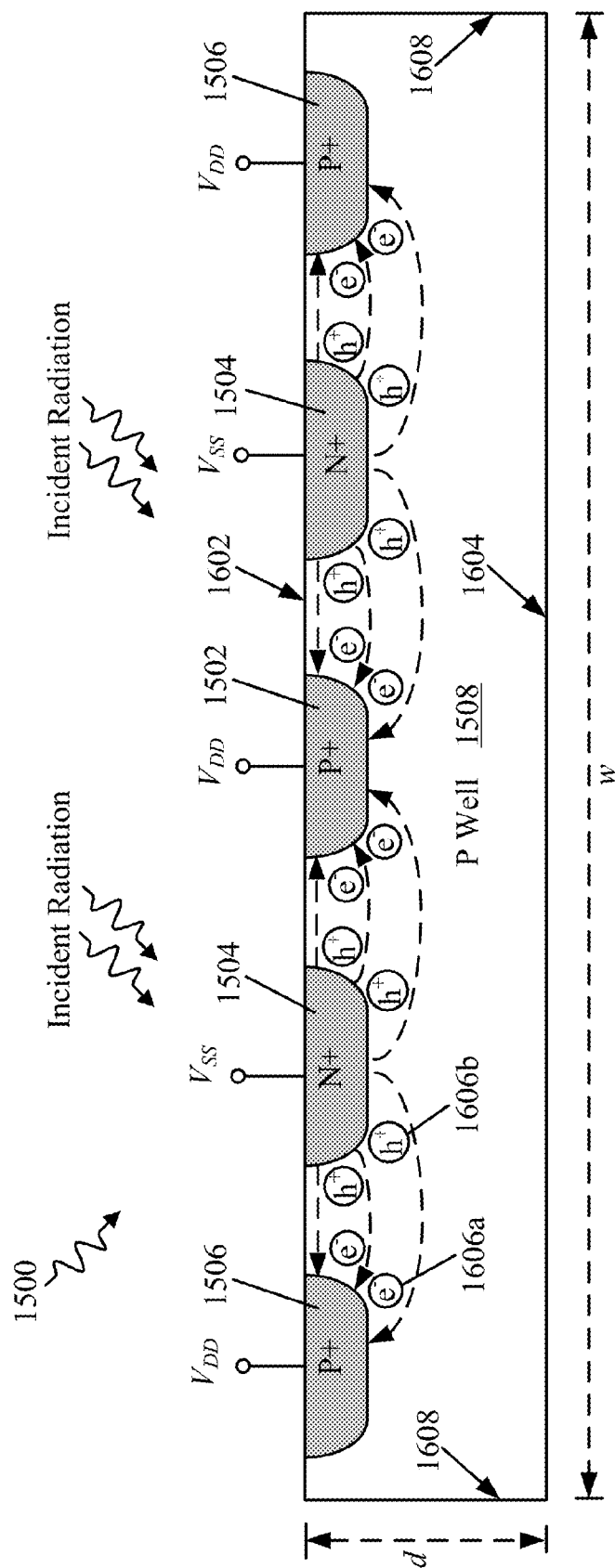


FIG. 16

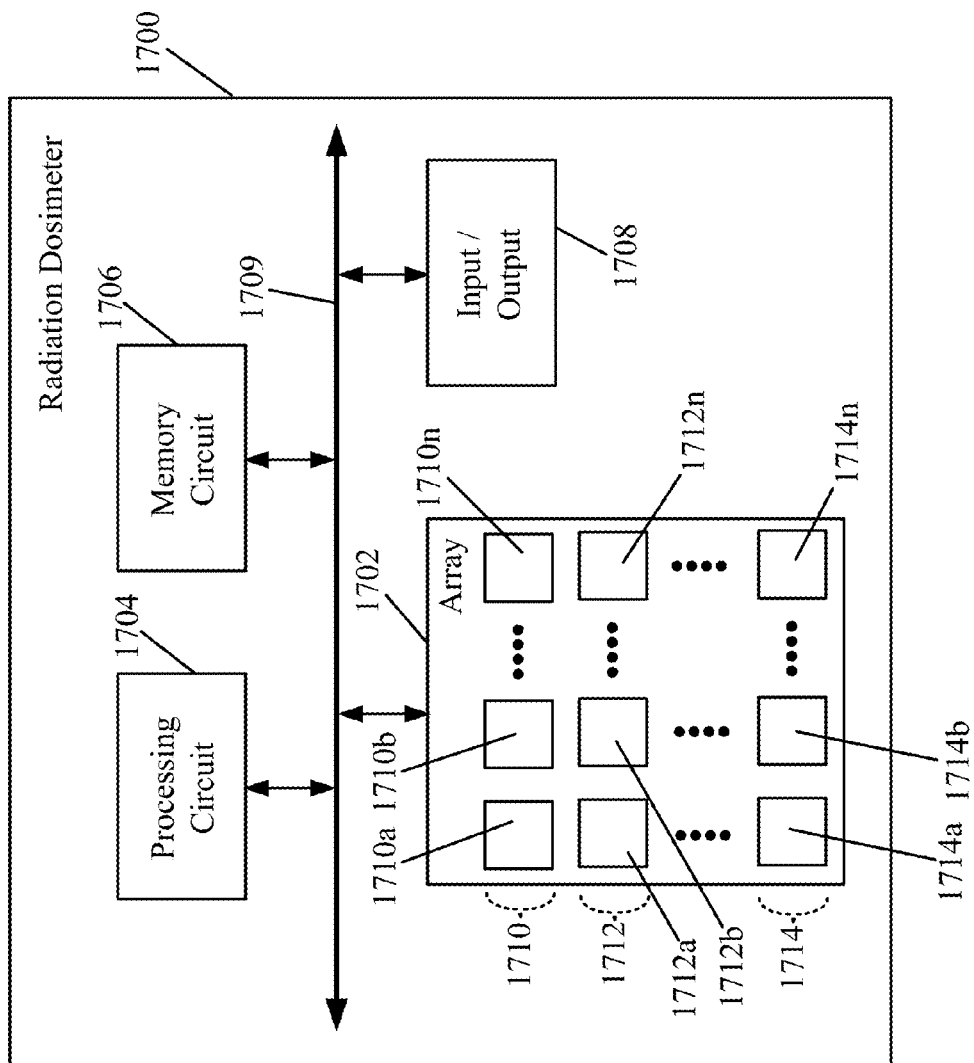


FIG. 17

1800

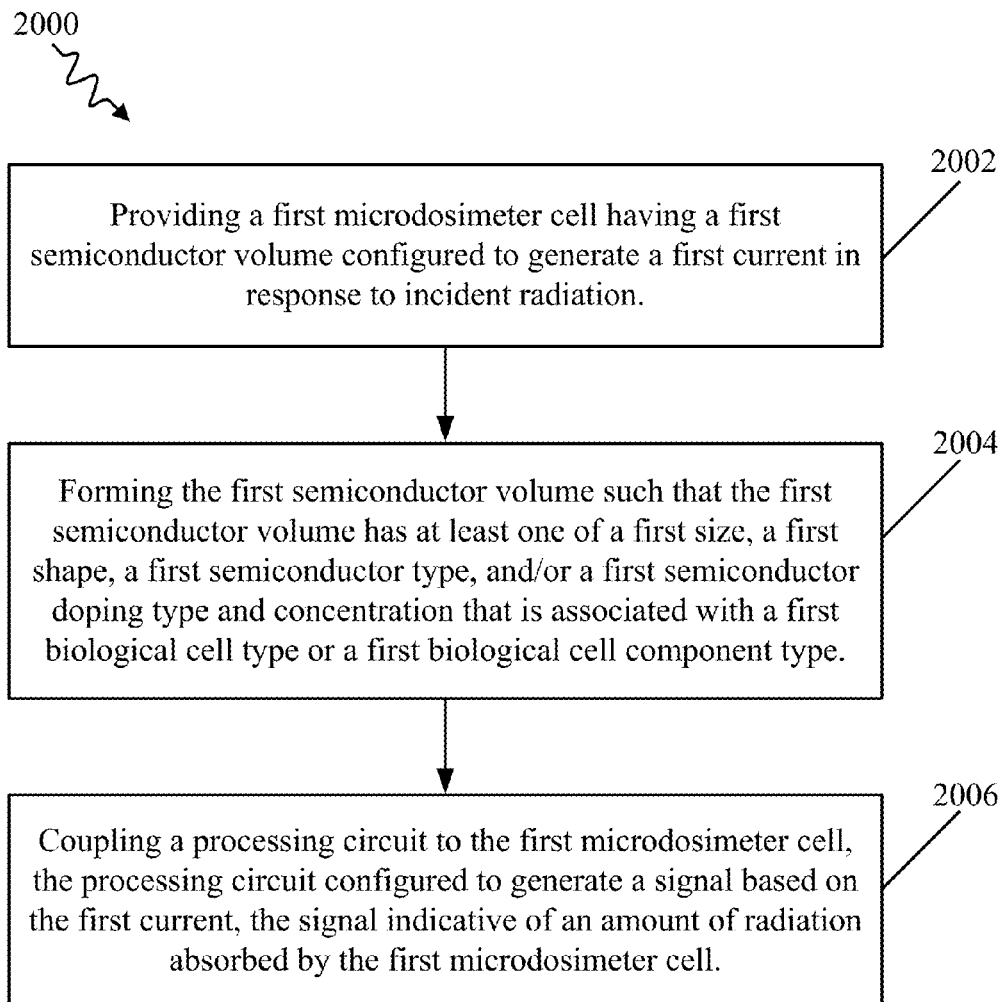
Biological Cell Type	Relative Radiation Sensitivity Scaling Factor (RRSSF)
Neutrophil Cell	0.25
Cortical Bone Cell	0.05
Skeletal Muscle Cell	0.06
Epithelial Colon Cell	0.28

FIG. 18

1900

Biological Cell Component Type	Relative Radiation Sensitivity Scaling Factor (RRSSF)
Mitochondrion	0.10
Golgi Apparatus	0.08
Nucleus	0.40
Specific Granule	0.03

FIG. 19

**FIG. 20**

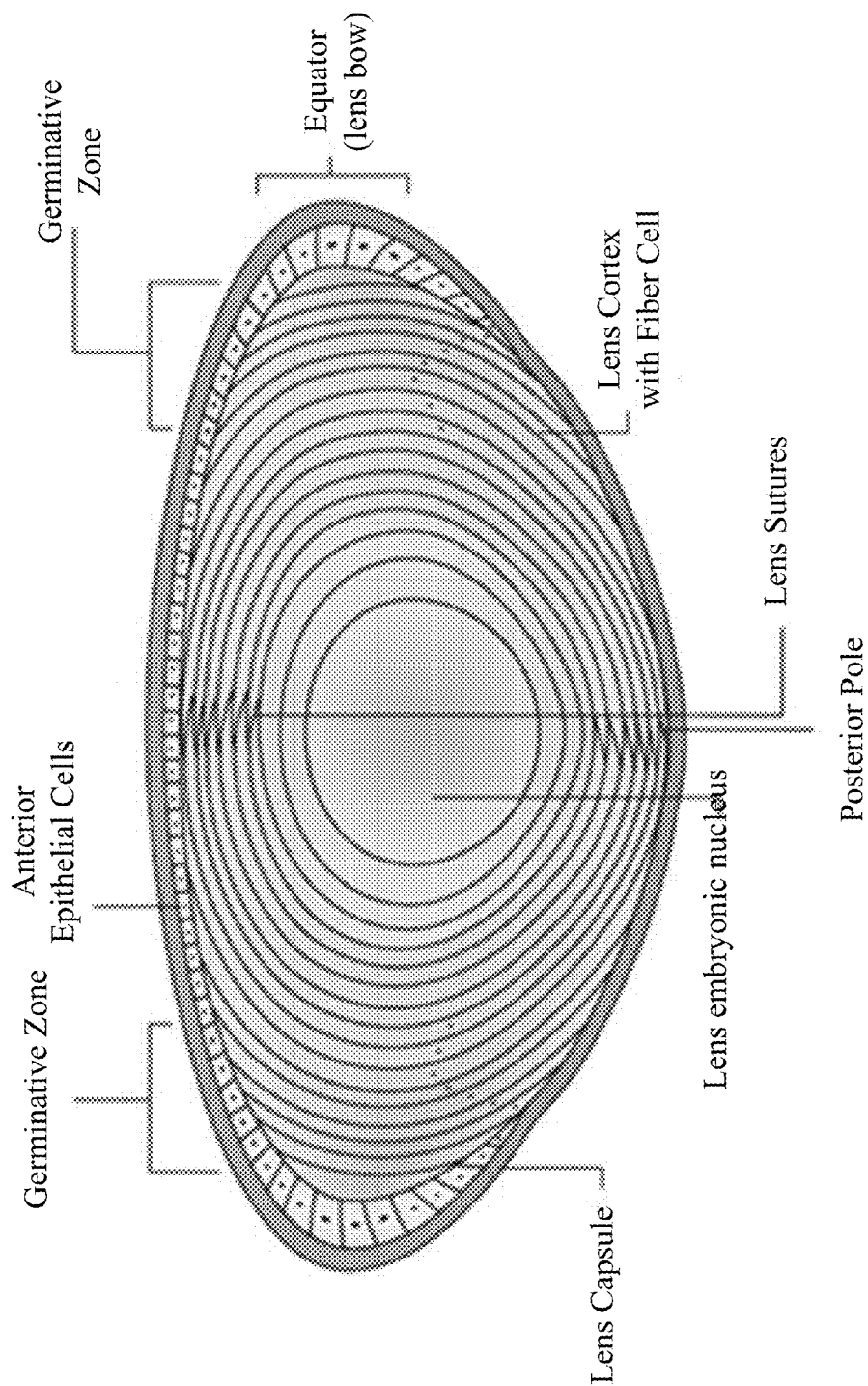


FIG. 21 (Prior Art)

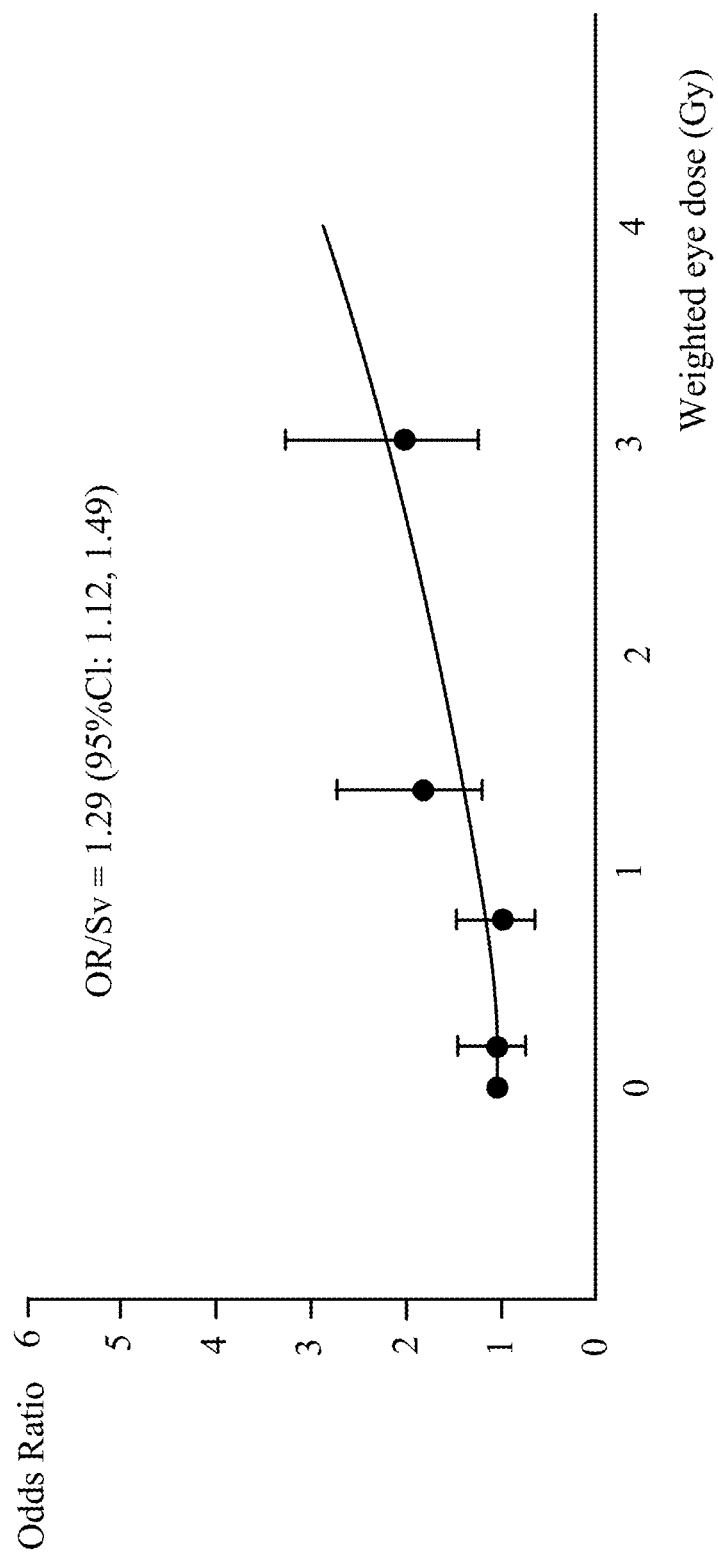


FIG. 22 (Prior Art)

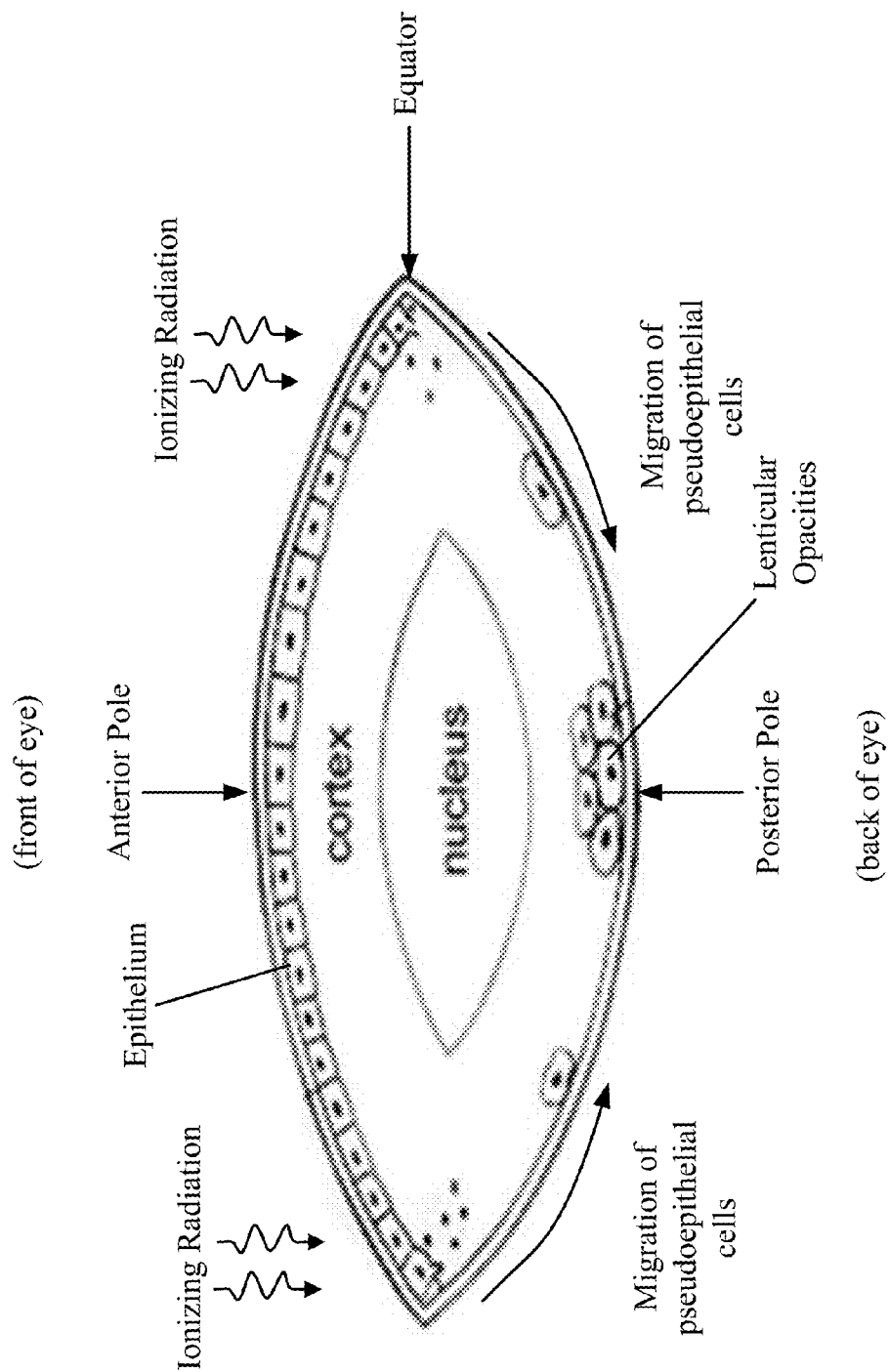


FIG. 23 (Prior Art)

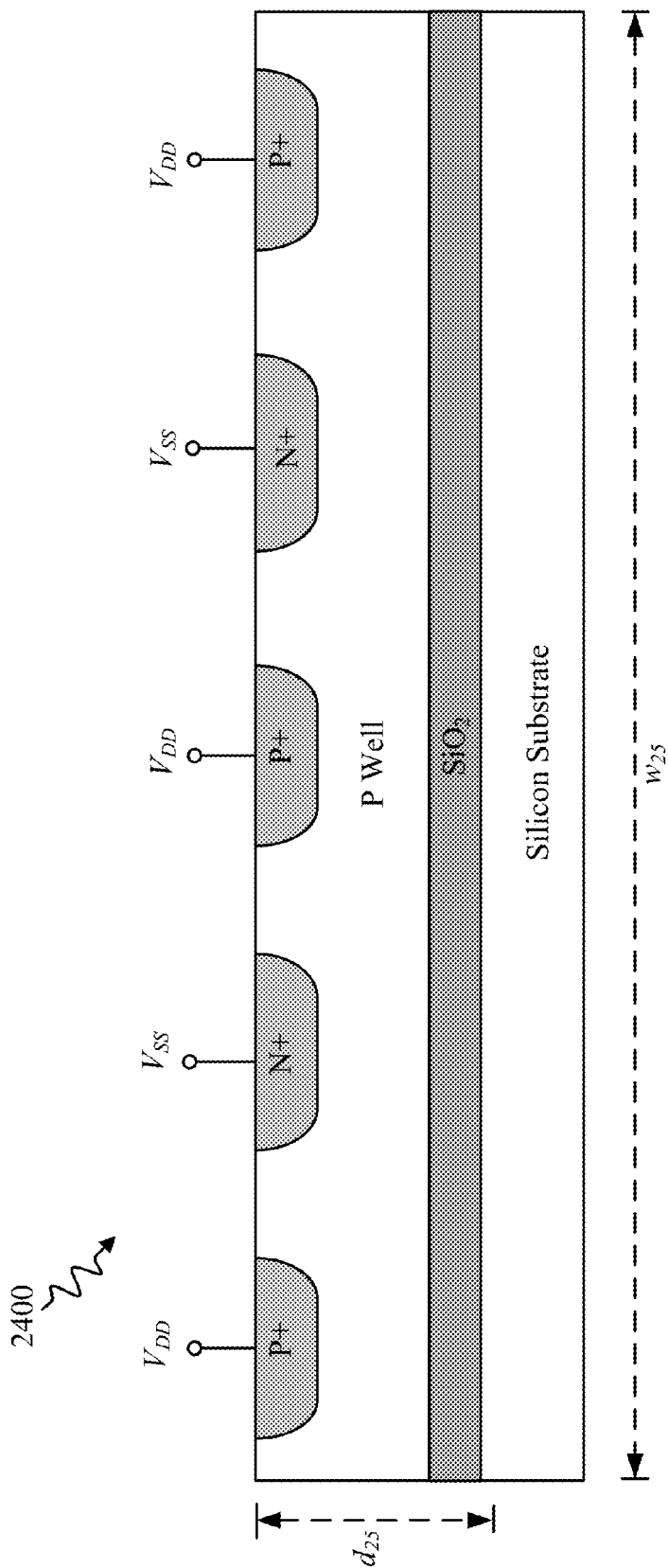


FIG. 24

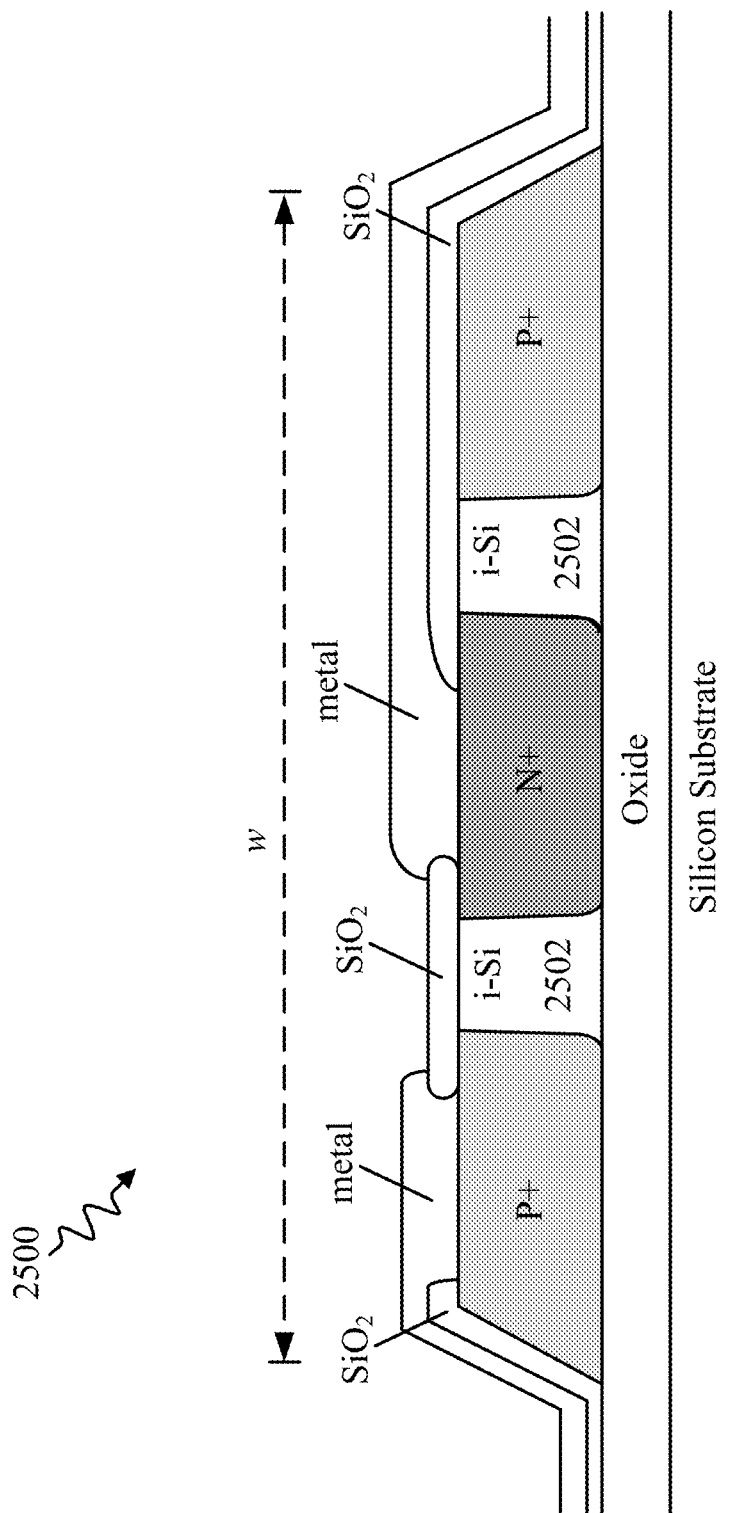


FIG. 25

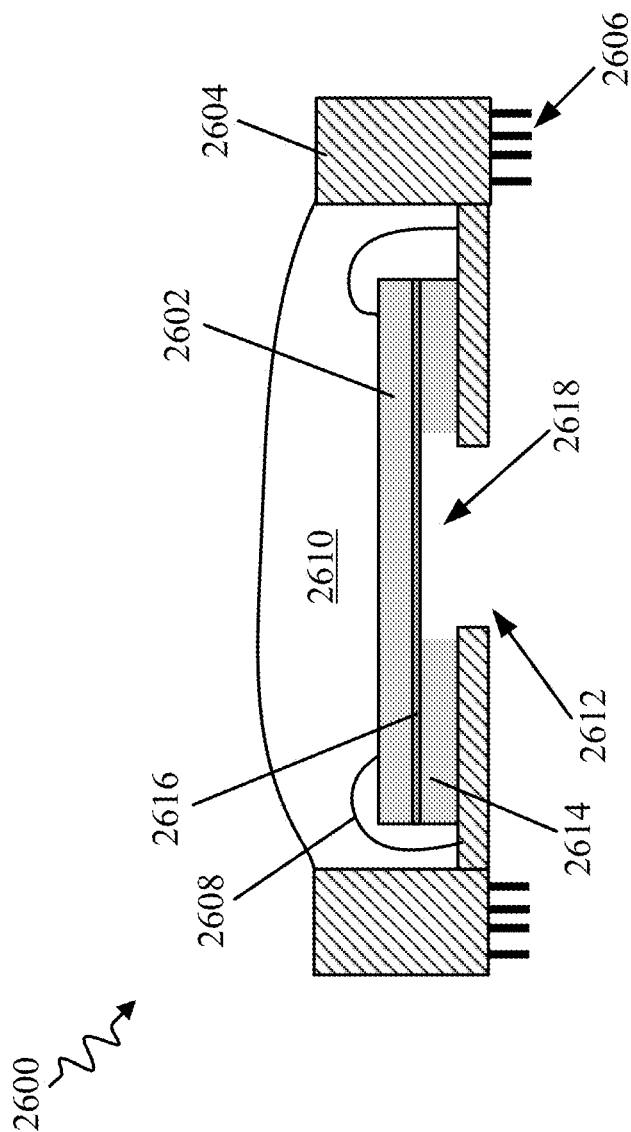


FIG. 26

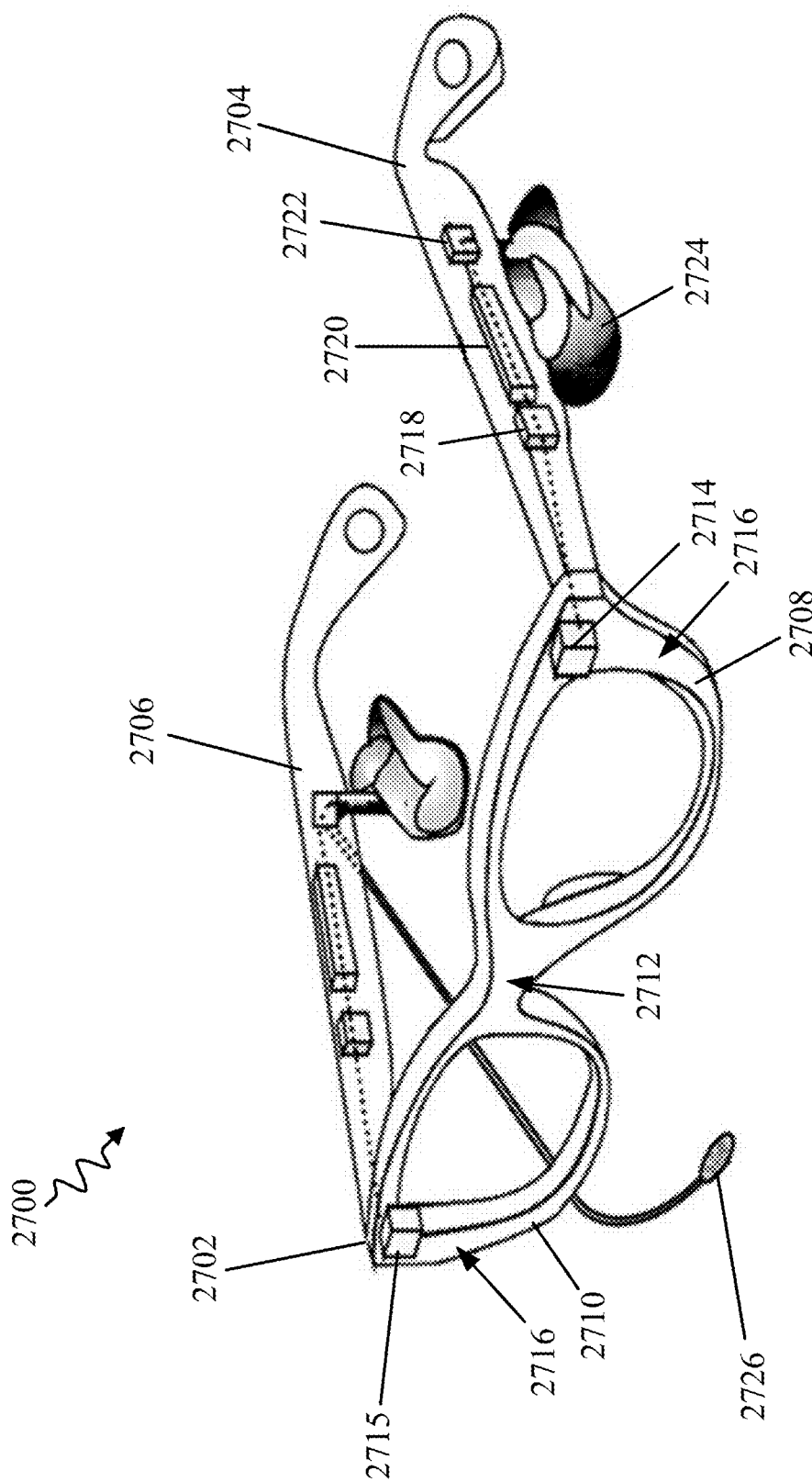


FIG. 27

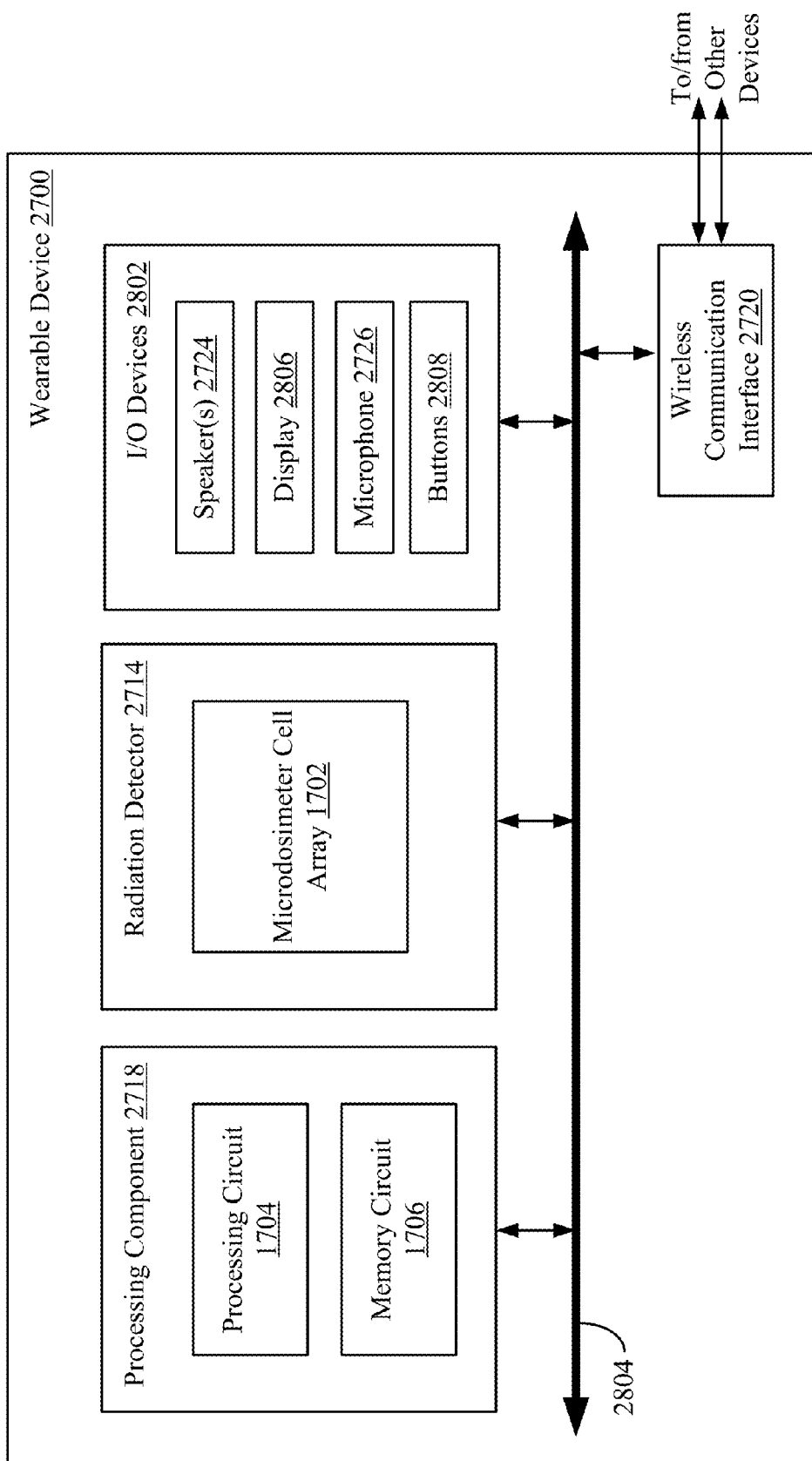
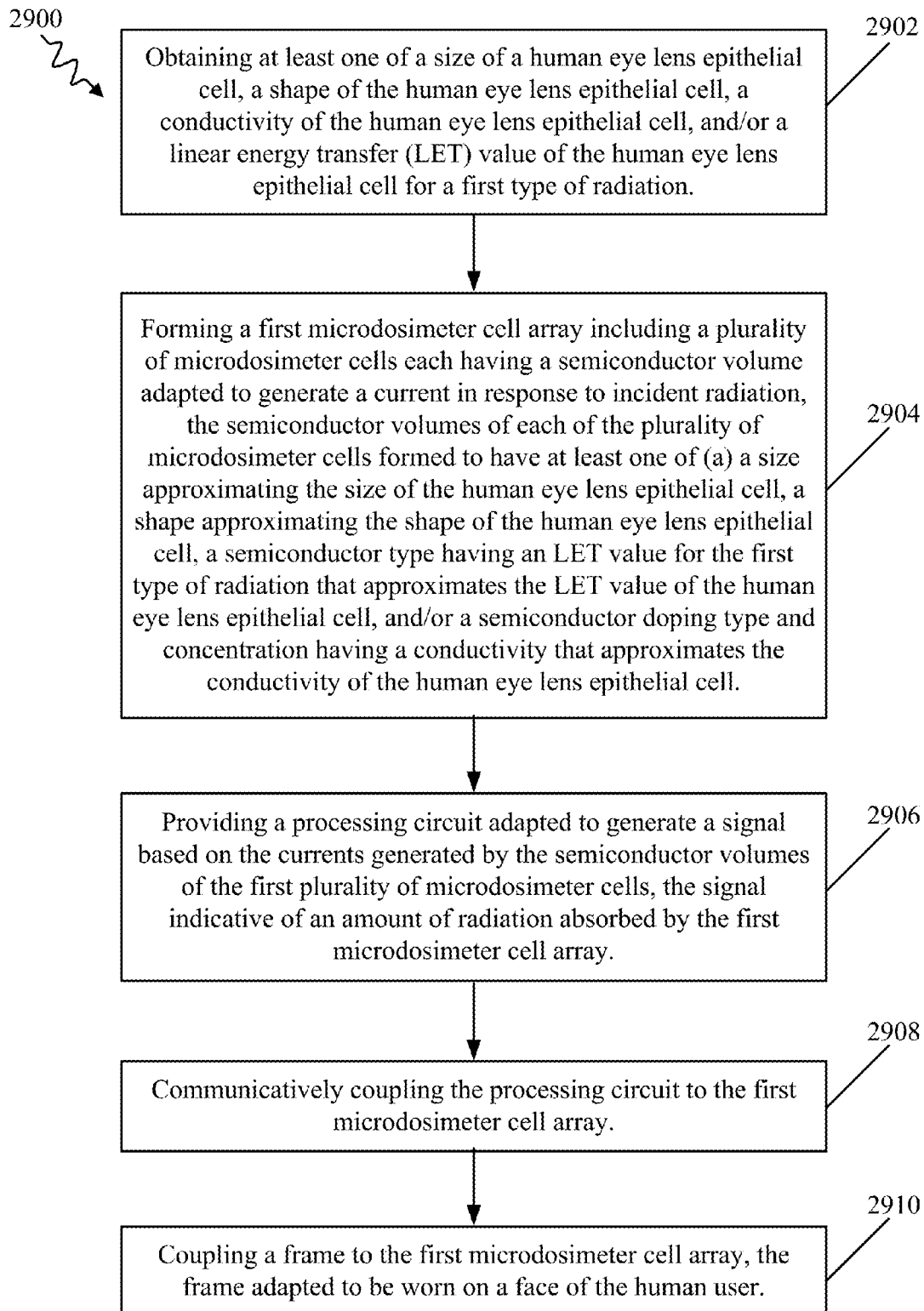


FIG. 28

**FIG. 29**

RADIATION DETECTING WEARABLE DEVICES

CLAIM OF PRIORITY

The present application for patent claims priority to provisional application No. 62/034,709 entitled "Microdosimeter Devices Utilizing Microdosimeter Cells Based on Eye Lens Epithelial Cells" filed Aug. 7, 2014 (hereby expressly incorporated by reference), and is a continuation-in-part of U.S. patent application Ser. No. 14/469,431 entitled "Radiation Microdosimeters Correlated with Biological Cells and Cell Components" filed Aug. 26, 2014, which is a continuation of U.S. patent application Ser. No. 13/959,616, now U.S. Pat. No. 8,858,888 entitled "Radiation Microdosimeters Correlated with Biological Cells and Cell Components" filed Aug. 5, 2013, which in turn claims priority to provisional application No. 61/739,580 entitled "Radiation Microdosimeter Correlated with Tissue Structures" filed Dec. 19, 2012, the entire disclosures of which are hereby expressly incorporated by reference.

BACKGROUND

Field

Various features relate to radiation microdosimeters, and more specifically, to solid state microdosimeters that mimic cells of the human eye.

Background

Classical radiation absorbed dosimetry operates to determine the average energy deposited per unit mass, J/kg, but cannot predict the radiobiological effects in biological tissue for the detected radiation. Early attempts at understanding radiation effects on tissue recognized that knowledge of the energy distribution at a scale comparable to the structures affected by irradiation was essential, and hence knowledge of the energy distribution at the cellular level and even DNA level. Consequently, the study of radiation effects on living cells or cell components is called "microdosimetry."

One of the factors affecting local energy deposition is termed "Linear Energy Transfer" (LET). LET is the linear density of energy lost by an ionizing particle travelling through matter. For example, it may be the loss of energy per unit distance along the path of charged particles. With micro-sized targets, deterministic energy deposition becomes stochastic and depends on the target size and spatial pattern of energy deposited by ionizing radiation (e.g., charged particles). These stochastic variations in energy deposition complicate the correlation of the LET approach with radiobiological effects.

There are several reasons for the limitations in the LET concept. First, the delta ray distribution and its relationship to spatial dose distributions are not adequately accounted for in most analyses. Also, particles with different velocities and charges can have the same LET but the particle velocity largely determines the energy distribution of delta rays. In microscopic volumes, the delta ray distribution may be a significant factor in the spatial distribution of energy, particularly at higher particle energies and smaller target tissue sizes. Further, LET is a non-stochastic average quantity, and it does not account for the random fluctuations in energy deposition which manifests as the clustering of energy deposition and range straggling of radiation particles. This variance due to straggling may exceed the path length variations at high particle energies and smaller tissue sizes.

These limitations in LET lead to the formulation of a set of measurable stochastic quantities, which produce the fun-

damental basis for the field of microdosimetry. Microdosimetry requires instrumentation for measurements of energy deposited in a cellular size or smaller. Instruments to approximate such measurements were developed in the 1940's, such as the low pressure gas proportional counter, also referred to as the "Rossi" counter. This dosimeter is still one of the most common radiation dosimeters, especially in a form known as a "Tissue-Equivalent Proportional Counter" (TEPC). A TEPC uses low-pressure gases, usually of a type that mimics tissue equivalent compounds, and may be surrounded by similar tissue-equivalent materials.

TEPCs have several shortcomings. First, TEPCs require a gas supply system that is inconvenient in many portable applications. Second, TEPCs are relatively large (e.g., 1 cm or larger in diameter), which severely limits the spatial resolution of any detected radiation. Third, TEPCs require high voltages, for example, up to 2,000 volts or more is commonplace. As such, TEPCs are relatively power-hungry devices that cannot be used in a passive mode for weeks or months at a time, since a TEPC cannot record radiation events without power. Fourth, TEPCs suffer from the "wall effect" and other size-related problems since they are very large compared to tissue cells and tissue cell components. This leads to artifacts in the analysis of their microdosimetry spectra. Finally, and most notably, very large gas volume correction factors are required to compensate for the difference between the TEPC gas volume (i.e., testing space volume used by the TEPC) and a condensed phase tissue structure volume (e.g., cell volume) that the TEPC is being used to estimate the radiation energy deposited within. Such a correction factor may be, for example, of the order of 18,000 times or more.

Microdosimetric spectra can be converted to radiobiological characteristics of the radiation field by convolution with a quality coefficient Q over the range of lineal deposited energies, which reflects increasing probability of cell inactivation with increasing lineal event energy. The coefficient Q is determined by the International Commission on Radiation Units and Measurements (ICRU) and based on experimental in-vitro cell survival measurements. Its analytical values are tabulated in Table 1 as a function of LET, the unrestricted linear energy transfer in water.

TABLE 1

Quality Coefficient - Q (LET)	
LET (keV/μm)	Q (LET)
<10	1
10-100	$(0.32 \times \text{LET}) - 2.2$
>100	$300/(\text{LET})^{0.5}$

The coefficient Q is thus a measure of the main difference between absorbed dose and equivalent (radiobiological) dose of radiation fields.

In addition to gas based TEPC radiation measurement devices, dosimetry systems may also utilize semiconductor detectors (e.g., solid state detectors). Solid state detectors allow for the fabrication of small sensitive volume (SV) sizes because of the availability of integrated circuit technology. SV refers to a volume that absorbs radiation energy. In some situations nanodosimetry is used instead of microdosimetry. In nanodosimetry, the small SV of the detector is used to measure absorbed dose or dose rate but with ultra-high spatial resolution. For example, metal oxide semiconductor field-effect-transistors (MOSFET) detectors (which have a very small SV of a few hundred nanometer size) are

able to measure absorbed doses with submicron spatial resolution. Such detectors, however, cannot distinguish the energy deposited in the SV due to a particular event. Instead, the output signal represents the integral of many events depositing energy in the SV. This limitation also occurs with many solid state detectors, such as dosimetric diodes working in current mode, thermo-luminescent dosimeters (TLDs), and film.

Passive solid state detectors can be used to some extent in microdosimetry. For example, glow peaks in some TLDs are sensitive to the LET of particles that are associated with energy deposition on the micron level. These detectors are not a suitable substitution for TEPCs, as they do not have sensitive LET resolution and cannot be used in real time dosimetry.

A passive microdosimetry detector (e.g., '199 dosimeter) disclosed in U.S. Pat. No. 5,596,199 records the energy deposition of incident radiation using an array of micro-structure non-volatile memory devices. The charge from incident charged particles is stored in an electrically insulated (floating) gate of micron or submicron scale SV of a floating gate avalanche injection metal-oxide-semiconductor (FAMOS) transistor. When this charge exceeds a threshold level, the state of the memory cell changes. The number of cells that have changed state is equal to the number of events that have deposited energy above the threshold. A predetermined initial charge is stored in each cell, which makes the charge increment required to change the state of the cells variable. This is claimed to provide a spectroscopy of the deposited energies, but it is a discreet spectroscopy rather than analogue or real spectroscopy. There can be uncertainty in the cause of the change-of-state resulting from a single event in the SV, or due to several consecutive events, thereby giving an incorrect indication of the radiation field. Owing to the passive mode of operation, the charge deposited in the SV is therefore less than on a floating gate. The charge deficit due to recombination depends on the LET of the particle. Recombination of charge in the gate oxide is well known in MOSFET detectors, and reduces the utility of MOSFET detectors for dosimetry in proton and heavy ions fields (even in an active mode). The '199 microdosimeter is designed principally to distinguish the gamma and neutron components of a radiation field, but it can only with difficulty obtain dose equivalent using the weighting coefficient Q in arbitrary radiation fields as recommended by the ICRU.

Another approach, based on the parallel connection of micron scale semiconductor detectors, such as p-n junctions, provides an active array of micron scale SVs. In this approach, reverse biased semiconductor detectors with micron scale semiconductor (e.g., silicon) SVs are connected to a nuclear spectroscopy system. The small area of the array of p-n junctions allows pulse pile up to be avoided, provided that charge is generated in a single SV only. This condition does not hold, however, if the charged particle traverses an SV in a direction substantially parallel to the surface of the semiconductor array. In such cases energy can be deposited in two SVs simultaneously, providing a greater charge than if it was deposited in a single SV. Spectroscopy information can be converted to dose equivalent using a weighting factor recommended by the ICRU. This technique has been demonstrated using planar arrays of p-n junctions of SRAMs with an SV size of 44x44x3 microns. Applications of such planar arrays of p-n junctions for regional microdosimetry are limited owing to uncertainty in the average chord, charge collection efficiency within the SV, over-layers, and shape of the SV.

Increasing the total area of the p-n junction array leads to increases in the noise owing to an increase in capacitance that reduces the minimal LET detected by the microdosimeter. A segmentation approach with several parallel readout spectroscopy channels has been suggested to reduce the noise of the microdosimeter. This method has been demonstrated in the separation of gamma/neutron field without any qualitative or quantitative (dose equivalent) characterization of the radiation field.

Charge collection spectroscopy in a micron-size array of planar p-n junctions (e.g., SVs) of a memory chip (e.g., SRAM) strongly depends on the fabrication technology, the angle of incidence of the radiation, and the SV shape. Hence, interpretation of the measured spectra for conversion to dose equivalent values is complex. A solid state semiconductor microdosimeter based on a parallel array of p-n junctions for measurements of tissue equivalent microdosimetric spectra has also been reported. The viability of measuring integral dose and microdosimetric spectra simultaneously at the same point in a water phantom in fast neutron therapy beam has also been demonstrated.

Cells may be considered the fundamental component of life. Therefore, whole-body radiation exposure measurements may be useful in detecting the presence of radiation exposure, but it is the radiation absorbed by the body's cells that is the essential metric in measuring relevant detrimental biological responses to radiation, such as acute tissue injury or late-occurring cancer induction. Traditional methods of measuring radiation safety such as using TPECs or TLDs are seriously limited because of the large scaling factor that has to be used (e.g. on the order 10^4 or more) in order to estimate the radiation energy deposited in a biological cell or a cell component. This correction which scales the measured energy deposited to that which would be absorbed by an actual cell is called the Radiation Detector Correction Factor (RDCF). Reducing the RDCF helps increase the accuracy of measurements that determine the actual radiation energy absorbed by a biological cell.

Note that non-isotropic radiation may be poorly assessed by planar arrays of detectors because different trajectories will yield inconsistent detector signals depending on the geometry of the array to the radiation path. Thus, there is a need to build detectors that mimic the substance and dimensions of cells that will allow the closest approximation to assessing radiation deposition in cells, and make the RDCF approach the ideal value of 1.0 (no correction needed).

The energy deposited in materials is strongly dependent on the availability of conduction electrons, and different tissues absorb energy depending, in part, on their electrical characteristics. Also, for some tissues such as bone, the high relative abundance of high atomic number materials such as calcium will have a significant effect on the energy absorbed. Thus, there is a need to build detectors that can mimic the variation in electrical conductivity of different cells and thereby reduce the RDCF on a cell-type basis.

There is a well-established link between ionizing radiation and the development of cataracts. Ionizing radiation has been particularly linked to the formation of posterior sub-capsular cataracts (PSCs). Some radiation workers are thought to be at increased risk for developing cataracts, such as interventional radiologists and nuclear power plant workers, because of the occupational radiation exposures to their eyes.

Among other things, the human eye includes a lens. The lens of the eye is one of the most radio-sensitive tissues in the body. This is due to the function of the eye, and that mere increased opacity of the lens can cripple the eye's function

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(visual acuity) without having any severe damage to cell viability. The lens epithelial cells are the most radiosensitive part of the lens, since they may turn opaque after exposure to small doses of radiation. Lens epithelial cells migrate towards the posterior pole as they mature into cortical fibers. In short, dividing lens epithelial cells are damaged by radiation, and opacifications are formed as they differentiate and migrate towards the posterior pole of the eye.

FIG. 21 illustrates several distinct regions that make up the human lens: the lens capsule to isolate the lens from the vasculature; a single anterior layer of epithelial cells; the elongated lens cortex with fiber cells; the germinative zones, the equator (lens bow), the lens sutures, the lens embryonic nucleus, and the posterior pole. If the actively dividing cells (e.g., lens epithelial cells) in the germinative region are damaged by radiation, they migrate to the posterior pole of the lens and can create lens opacity.

Human lens epithelial cells are cuboidal or cylindrical in shape and their size varies moderately between individuals. According to one study, lens epithelial cell diameter sizes ranged from 8 μm to 21 μm , with 97% of the cells measuring 9 μm to 17 μm in diameter. There is also a difference in size between cells grown in culture and cells in vivo. Lens epithelial cells grown in culture have an average diameter of about 30 μm . Lens epithelial cells in vivo have an average diameter from 12 μm to 15 μm . This latter decrease in diameter may be due to compressive pressures from the full in-vitro lens structure, and is more accurate. Thickness estimates for lens epithelial cells range from 5 μm to 10 μm .

FIG. 22 illustrates the relation between radiation exposure and the cortical opacity of the lens. A radiation cataract causes partial opacity or cloudiness in the crystalline lens and results from damaged cells covering the posterior surface of the lens. Symptoms can appear as early as one or two days following high-dose exposure and many months after exposure to lower doses. The incidence rate of radiation for cataractogenesis is uncertain, although a recent study reported a 20-30% increase in incidence rate at 1 Gy of exposure of cataracts that prompted lens replacement surgery. Traditionally it was assumed that a low-dose threshold existed, below which radiation does not produce cataracts. However, recent research suggests that if a threshold exists, it is somewhere in the exposure range of 0.8 Gy or less. The excess cataracts seen are of the types generally associated with radiation exposure: posterior subcapsular and cortical cataracts.

FIG. 23 illustrates how radiation is thought to cause lens opacity. There is a transparent layer of epithelial cells on the interior frontal side of the capsule that covers the lens. This layer maintains the function of the lens by slowly growing toward the center, achieved through cell division at the periphery (called the equator) of the lens. Because radiation is especially harmful to dividing cells, exposed cells at the equator are most prone to damage. Damaged cells move toward the rear of the lens before converging on the center. Such cells prevent, light from traveling straight forward resulting in opacity.

In the context of radiation cataractogenesis, knowledge of absorbed dose is essential but not sufficient. This is because an important risk-modifying, factor in radiocataractogenesis is the quality and/or type of the radiation. For example, for a given amount of absorbed dose, neutron radiation is more effective at producing cataracts compared with x-rays. The relative biological effectiveness (RBE) of a radiation of interest quantifies its biologic effectiveness relative to low energy photons. The RBE of neutrons, charged particles, and other radiations depends on the kinetic energy, velocity,

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directionality, and other physical properties of the radiation and the person they are incident upon. In cases where the characteristics of the radiation in the lens is not known a priori, it must be determined by measurement, calculation, or subjective judgment. Measurements should include separate quantification of absorbed dose (the physical component of the radiation exposure) and the radiation type to characterize the relevant biologic aspects of the radiation.

SUMMARY

One feature provides a wearable device adapted to be worn by a human user, the wearable device comprising a first microdosimeter cell array including a first plurality of microdosimeter cells each having a semiconductor volume adapted to generate a current in response to incident radiation, the semiconductor volumes of each of the first plurality of microdosimeter cells having at least one of a size, a shape, a semiconductor type, and/or a semiconductor doping type and concentration that is associated with one or more cells or cell components of a human eye, and a processing circuit communicatively coupled to the first microdosimeter cell array and adapted to generate a first signal based on the currents generated by the semiconductor volumes of the first plurality of microdosimeter cells, the first signal indicative of an amount of radiation absorbed by the first microdosimeter cell array. According to one aspect, the one or more cells or cell components of the human eye include epithelial cells of the human eye. According to another aspect, the wearable device further comprises an output device communicatively coupled to the processing circuit, the output device adapted to output radiation information based on the first signal to the human user.

According to one aspect, the radiation information warns the human user that radiation levels have been detected that may cause cataracts and/or blindness to the human user. According to another aspect, the wearable device further comprises a frame adapted to couple to a face of the human user, the first microdosimeter cell array coupled to the frame. According to yet another aspect, the frame is an eye glass frame.

According to one aspect, the first microdosimeter cell array is positioned on a first rim, a first temple, and/or a bridge of the frame between the first rim and a second rim. According to another aspect, the wearable device further comprises a second microdosimeter cell array coupled to at least one of the second rim and/or a second temple of the frame, the second microdosimeter cell array including a second plurality of microdosimeter cells each having a semiconductor volume adapted to generate a current in response to incident radiation, the semiconductor volumes of each of the second plurality of microdosimeter cells having at least one of a size, a shape, a semiconductor type, and/or a semiconductor doping type and concentration that is associated with one or more cells or cell components of the human eye, and wherein the processing circuit is communicatively coupled to the second microdosimeter cell array and adapted to generate a second signal based on the currents generated by the semiconductor volumes of the second plurality of microdosimeter cells, the second signal indicative of an amount of radiation absorbed by the second microdosimeter cell array.

According to one aspect, the first microdosimeter cell array has a silicon on insulator (SOI) structure having at least a portion of a bottom silicon substrate layer under an insulator layer removed to form a cavity exposing the insulator layer. According to another aspect, the cavity is

filled with a tissue equivalent material. According to yet another aspect, the wearable device further comprises a microphone communicatively coupled to the processing circuit and adapted to receive voice commands from the user that retrieve radiation information from the processing circuit, the radiation information indicative of the amount of radiation absorbed by the first microdosimeter cell array.

According to one aspect, the wearable device further comprises a wireless communication interface communicatively coupled to the processing circuit, the wireless communication interface adapted to transmit, to another device, a message that includes information indicative of the amount of radiation absorbed by the first microdosimeter cell array. According to another aspect, the semiconductor volumes of the first plurality of microdosimeters each have a lateral dimension ranging from 4 μm to 100 μm .

Another feature provides a wearable device adapted to be worn by a human user, the wearable device comprising a microdosimeter cell array including a first microdosimeter cell and a second microdosimeter cell, the first microdosimeter cell having a first semiconductor volume configured to generate a first current in response to incident radiation, the first semiconductor volume having at least one of a first size, a first shape, a first semiconductor type, and/or a first semiconductor doping type and concentration that is associated with a first type of human eye cell or human eye cell component, the second microdosimeter cell having a second semiconductor volume configured to generate a second current in response to the incident radiation, the second semiconductor volume having at least one of a second size, a second shape, a second semiconductor type, and/or a second semiconductor doping concentration that is associated with a second type of human eye cell or a human eye cell component, the first type of human eye cell or human eye cell component being different than the second type of human eye cell or human eye cell component, and wherein at least one of the second size is different than the first size, the second shape is different than the first shape, the second semiconductor type is different than the first semiconductor type, and/or the second semiconductor doping concentration is different than the first semiconductor doping concentration, and a processing circuit communicatively coupled to the microdosimeter cell array and configured to generate a signal based on the first current and the second current, the signal indicative of an amount of radiation absorbed by the microdosimeter cell array. According to one aspect, the wearable device further comprises an output device communicatively coupled to the processing circuit, the output device adapted to output an audio or visual warning indicating that radiation levels have been detected that may cause cataracts and/or blindness. According to yet another aspect, the wearable device further comprises a frame adapted to couple to a face of the human user, the microdosimeter cell array coupled to the frame.

Another feature provides a method of manufacturing a wearable device adapted to be worn by a human user, the method comprising obtaining at least one of a size of a human eye lens epithelial cell, a shape of the human eye lens epithelial cell, a conductivity of the human eye lens epithelial cell, and/or a linear energy transfer (LET) value of the human eye lens epithelial cell for a first type of radiation, and forming a first microdosimeter cell array including a plurality of microdosimeter cells each having a semiconductor volume adapted to generate a current in response to incident radiation, the semiconductor volumes of each of the plurality of microdosimeter cells formed to have at least one of (a) a size approximating the size of the human eye lens

epithelial cell, a shape approximating the shape of the human eye lens epithelial cell, a semiconductor type having an LET value for the first type of radiation that approximates the LET value of the human eye lens epithelial cell, and/or a semiconductor doping type and concentration having a conductivity that approximates the conductivity of the human eye lens epithelial cell. According to one aspect, the method further comprises providing a processing circuit adapted to generate a signal based on the currents generated by the semiconductor volumes of the first plurality of microdosimeter cells, the signal indicative of an amount of radiation absorbed by the first microdosimeter cell array, and communicatively coupling the processing circuit to the first microdosimeter cell array. According to another aspect, the method further comprises coupling a frame to the first microdosimeter cell array, the frame adapted to be worn on a face of the human user.

BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1 illustrates a schematic block diagram of a radiation microdosimeter.

FIG. 2 illustrates a schematic top view of a detector cell of the radiation microdosimeter.

FIG. 3 illustrates a schematic cross-sectional view of the detector cell.

FIG. 4 illustrates another schematic cross-sectional view of the detector cell.

FIG. 5 illustrates a schematic cross-sectional view of a human neutrophil white blood cell.

FIG. 6 illustrates a schematic top view of a detector cell having a semi-circular shape.

FIG. 7 illustrates a schematic cross-sectional view of the detector cell having the semi-circular shape.

FIG. 8 illustrates an exemplary LET plot that shows the energy transfer of a proton/hydrogen nuclei traveling through three types of semiconductors, water, and cortical bone.

FIG. 9 illustrates an example of an exemplary LET plot that shows the energy transfer of protons traveling through silicon and skeletal muscle.

FIG. 10 illustrates an example of an exemplary LET plot that shows the energy transfer of protons traveling through germanium and cortical bone.

FIG. 11 illustrates a schematic top view of another exemplary detector.

FIG. 12 illustrates a schematic cross-sectional view of the detector shown in FIG. 11.

FIG. 13 illustrates a schematic top view of yet another detector.

FIG. 14 illustrates a schematic cross-sectional view of the detector shown in FIG. 13.

FIG. 15 illustrates a schematic top view of yet another detector.

FIG. 16 illustrates a schematic cross-sectional view of the detector shown in FIG. 15.

FIG. 17 illustrates a schematic block diagram of another radiation dosimeter.

FIG. 18 illustrates a table that shows exemplary relative radiation sensitivity scaling factors for various biological cell types associated with a biological organism.

FIG. 19 illustrates another table that shows exemplary relative radiation sensitivity scaling factors for various biological cell component/organelle types associated with a biological cell.

FIG. 20 illustrates a flow chart of an exemplary method.

FIG. 21 illustrates several distinct regions that make up the human lens.

FIG. 22 illustrates the relation between radiation exposure and the cortical opacity of the lens.

FIG. 23 illustrates how radiation causes lens opacity.

FIG. 24 illustrates an exemplary microdosimeter cell that may be fabricated having a silicon-on-insulator (SOI) structure and also an approximate size and/or shape of an eye lens epithelial cell.

FIG. 25 illustrates a "Mesa" cross-section microdosimeter can be constructed using integrated circuit technology

FIG. 26 illustrates schematically an SOI microdosimeter.

FIG. 27 illustrates a wearable device that detects radiation.

FIG. 28 illustrates a schematic block diagram of a wearable device.

FIG. 29 illustrates a method of manufacturing a wearable device featuring one or more microdosimeter cell arrays.

DETAILED DESCRIPTION

In the following description, specific details are given to provide a thorough understanding of the various aspects of the disclosure. However, it will be understood by one of ordinary skill in the art that the aspects may be practiced without these specific details. For example, circuits may be shown in block diagrams in order to avoid obscuring the aspects in unnecessary detail. In other instances, well-known circuits, structures and techniques may not be shown in detail in order not to obscure the aspects of the disclosure.

The word "exemplary" is used herein to mean "serving as an example, instance, or illustration." Any implementation or aspect described herein as "exemplary" is not necessarily to be construed as preferred or advantageous over other aspects of the disclosure. Likewise, the term "aspects" does not require that all aspects of the disclosure include the discussed feature, advantage or mode of operation. The term "communicatively coupled" is used herein to mean that two or more elements may communicate with one another (e.g., by transmitting signals between them) either directly or indirectly and via wirelessly or through wired connection.

The terms wafer and substrate may be used herein to include any structure having an exposed surface with which to form an integrated circuit (IC) according to aspects of the present disclosure. The term substrate is understood to include semiconductor wafers. The term substrate is also used to refer to semiconductor structures during fabrication, and may include other layers that have been fabricated thereupon. The term substrate includes doped and undoped semiconductors, epitaxial semiconductor layers supported by a base semiconductor, or semiconductor layers supported by an insulator, as well as other semiconductor structures well known to one skilled in the art. The term insulator is defined to include any material that is less electrically conductive than materials generally referred to as conductors by those skilled in the art. The term "horizontal" is defined as a plane substantially parallel to the conventional plane or surface of a wafer or substrate, regardless of the orientation of the wafer or substrate. The term "vertical" refers to a direction substantially perpendicular to the horizontal as defined above. Prepositions, such as "on," "upper," "side," "higher," "lower," "over," and "under" when used with respect to the integrated circuits described herein are defined with respect to the conventional plane or surface being on the top surface of the wafer or substrate, regardless of the orientation of the wafer or substrate. The prepositions

"on," "upper," "side," "higher," "lower," "over," and "under" are thereby defined with respect to "horizontal" and "vertical."

P-type conductivity is conductivity associated with holes in a semiconductor material, and n-type conductivity is conductivity associated with electrons in a semiconductor material.

Overview

A radiation detector that has the shape and/or size of an individual biological cell type or cell component type is disclosed. The radiation detector may also be fabricated to approximate the biological cell or cell component type's absorption of radiation. For example, this may be accomplished by fabricating the detector with different semiconductors, and/or using various dopants to adjust for approximate cell composition and absorption characteristics. It is noted that human tissue cells vary with tissue function. In general, radiation is most deleterious to cells whose function involves continuous cell division, such as, but not limited to spermatogonia, erythroblasts, epidermal stem cells, eye lens epithelial cells, and gastrointestinal stem cells. Other cells that do not necessarily involve rapid, continuous cell division yet are still very sensitive to radiation are oocytes and lymphocytes. Thus, the radiation detector may include an array of semiconductor detectors each having different sizes, shapes, and dopants—to mimic the cells found in biological tissue that is, for example, especially sensitive to radiation, such as the aforementioned cell types. The different detectors of the array can have individual "quality factors," and the total radiation exposure level can be determined by weighting the various detectors by their distribution in the body.

Since the detector arrays may be very small, they may be embedded in tissue-equivalent absorbers to mimic the radiation reaching them if they are deep within the body. Such tissue-equivalent absorbers may be plastics such as polyethylene or water. In some aspects, this may help increase the accuracy of measuring absorbed radiation. Depending on the physical characteristics of the absorber, the presence of the absorbed dose reading may decrease due to attenuation of the radiation, increase due to buildup of secondary radiation, or remain unchanged due to competing effects.

According to one aspect, the present disclosure provides a microdosimeter, comprising an array of three-dimensional p-n junction semiconductor detectors, each providing a sensitive volume-target (e.g., semiconductor volume) that correlates to cells or cell components. The semiconductor volume may be further encased or covered by a tissue equivalent medium to better approximate the radiation reaching the cell or cell component that the microdosimeter cell array mimics. The tissue equivalent medium generates secondary charged particles that may also be detected and measured by the semiconductor volume.

According to one aspect, the radiation detector may approximate the size of specific cells in tissue, such as, but not limited to, white blood cells, bone cells, gastro-intestinal cells. According to another aspect, the radiation detector may approximate the size of cell components, such as, but not limited to, a cell nucleolus. According to another aspect, the detector may approximate the radiation absorption characteristics of specific cells and/or cell components by doping the semiconductor of the detector to equivalent electrical characteristics. According to yet another aspect, the detector may approximate the radiation absorption characteristics of specific cells and/or cell components by doping the semiconductor to equivalent radiation absorption characteristics. According to another aspect, the detector may approximate

the radiation absorption characteristics of specific cells and/or cell components by using a semiconductor that has equivalent radiation absorption characteristics.

Biological cells from different tissues of the body differ from one another across a wide range of features and characteristics including but not limited to their size, shape, electrical conductivity, and linear energy transfer (LET) values (i.e., the rate of linear energy transferred to the cell by ionizing particles travelling through cell). Similarly, different biological cell components within a single cell also differ from one another across, among other things, their size, shape, electrical conductivity, and LET values. Notably, the microdosimeters described herein feature detector cells that include semiconductor volumes that have at least one of a size, shape, electrical conductivity, and/or LET value(s) that correspond to and approximately match the size, shape, electrical conductivity, and/or LET value(s) of a biological cell type or biological cell component type in order to reduce the Radiation Detector Correction Factor (RDCF) needed and thus more accurately approximate the actual radiation absorbed by the biological cell type or cell component type.

Exemplary Microdosimeter

FIG. 1 illustrates a schematic block diagram of a radiation microdosimeter 100 according to one aspect of the present disclosure. The microdosimeter 100 includes a detector array 102 coupled to a processing circuit 104. The detector array 102 includes one or more individual detectors 106 (may also be referred to herein as “detector cells” and “microdosimeter cells”). As will be explained in greater detail below, the detectors 106 generate a current and/or electric charge in proportion to the amount of ionizing radiation they are exposed to. The processing circuit 104 receives and/or monitors the current and/or electric charge generated by the detectors 106 and then calculates a radiation level value based on the current and/or electric charge. The microdosimeter 100 may then display the radiation level value calculated to a user of the microdosimeter 100 in order to ascertain detrimental health effects from radiation exposure. According to one example, the processing circuit 104 is configured to generate a signal based on the one or more currents and/or electric charges generated by the one or more detectors 106, and the signal generated is indicative of an amount of radiation absorbed by the microdosimeter cell array 102.

FIGS. 2 and 3 illustrate schematic views of a single detector cell 106 according to one aspect. Specifically, FIG. 2 shows a top view of the detector 106, and FIG. 3 shows a cross-sectional view of the detector 106 taken along the line 3-3 of FIG. 2. Referring to FIGS. 2 and 3, the radiation microdosimeter cell 106 comprises a first semiconductor region 202 and a second semiconductor region 204. The first semiconductor region 202 may be a heavily doped n-type semiconductor region (e.g., N+ region) and the second semiconductor region 204 may be a heavily doped p-type semiconductor region (e.g., P+ region). In this example, the second semiconductor region 204 forms a concentric oval-shaped ring that surrounds the inner, first semiconductor region 202. The first and second semiconductor regions 202, 204 may reside in a p-type semiconductor well 206. The p-type semiconductor well 206 may contain concentrations of a p-type dopant (e.g., boron, gallium, etc.) that are order(s) of magnitude less than the heavily doped p+ type semiconductor region 204. Both the first and second semiconductor regions 202, 204 serve as contact points for electrical conductors 306a, 306b, 306c, such as ohmic contacts. The electrical conductors 306a, 306b, 306c transmit current signals generated within the detector 106 to the

processing circuit 104 (see FIG. 1). Although in the example illustrated in FIGS. 2-3 the first semiconductor region 202 includes one electrical contact 306b, according to other examples the first semiconductor region 202 may have a plurality of contacts. Similarly, in the example shown the second semiconductor region 204 includes two electrical contacts 306a, 306c, but in other aspects it may include any number of electrical contacts equal to or greater than one (1).

Each detector cell of the microdosimeters described herein has a “radiation-sensitive semiconductor volume” associated with it that—as will be more fully described below—absorbs energy from ionizing radiation, and in response generates currents (e.g., an electron current and a hole current created by electron-hole pairs) and/or electric charge proportional to the amount of radiation absorbed. Thus, the radiation-sensitive semiconductor volume (also referred to herein as “semiconductor volume”) comprises that portion of the detector cell’s semiconductor material that is capable of absorbing the ionizing radiation and generating the aforementioned currents and/or electric charge.

For example, referring to FIGS. 2 and 3, the semiconductor volume includes at least the semiconductor well 206. Thus, according to one aspect, the detector’s 106 semiconductor volume (SV) may be equal to the detector width w multiplied by the detector length l multiplied by the detector depth d less the volumes V_{R1} and V_{R2} occupied by the first and second semiconductor regions 202, 204, respectively (equation (1)).

$$SV = w * l * d - (V_{R1} + V_{R2}) \quad (1).$$

According to another aspect, in addition to the semiconductor well 206, the semiconductor volume may further include the first and/or second semiconductor regions 202, 204. Thus, according to one aspect, the detector’s 106 semiconductor volume may be equal to the detector width w multiplied by the detector length l multiplied by the detector depth d (equation (2)).

$$SV = w * l * d \quad (2).$$

The microdosimeter cell 106 may also have a device width w_x that extends from the midpoint of one end of the second semiconductor region 204 to the midpoint of another end (directly across the diameter) of the second semiconductor region 204 as shown in FIG. 3. The dimensions of width (detector or device) and length may herein be referred to as a “lateral dimension.”

FIG. 4 also illustrates a schematic cross-sectional view of the detector 106 taken along the line 3-3 of FIG. 2. Specifically, FIG. 4 demonstrates the effects of ionizing incident radiation upon a first surface 302 (e.g., top surface) of the detector 106 according to one aspect of the disclosure. The ionizing incident radiation may be, for example, cosmic rays, alpha particles, beta particles, gamma rays, x-rays, neutrons, and/or generally any charged particle moving at relativistic speeds. In the illustrated example, the detector’s semiconductor volume (e.g., p-type well 206) absorbs at least a portion of the incident radiation energy. As the semiconductor volume absorbs radiation energy, electron-hole pairs 402a, 402b are generated in the semiconductor volume as shown. The greater the amount of radiation energy absorbed by the semiconductor volume the greater the number of electron-hole pairs 402a, 402b generated. When a voltage is applied between the first and second semiconductor regions 202, 204 as shown (e.g., positive supply voltage V_{DD} applied to the P+ type second semiconductor region 204 and ground V_{SS} applied to N+ type first

semiconductor region **202**), an electric field (indicated by the dashed arrows) is created within the semiconductor volume.

The electron-hole pairs **402a**, **402b** generated by the absorbed radiation are drawn apart by the electrical field such that electrons **402a** move to the P+ type semiconductor region **204** electrical contacts **306a**, **306c** and holes **402b** move to the N+ type semiconductor region **202** electrical contact **306b**. These charges **402a**, **402b** produce a current within the semiconductor volume that can be measured and analyzed to determine the amount of radiation absorbed in the semiconductor volume. According to one example, the electron **402a** current flowing toward the P+ type semiconductor region electrical contacts **306a**, **306c** may be analyzed rather than the hole **402b** current flowing into the N+ type semiconductor region electrical contact **306b** since the electrons **402a** generated by the absorbed radiation have approximately three times the velocity (mobility) of the holes **402b**. For example, the electron **402a** current flowing into the P+ type semiconductor region **204** may form a sharper electronic pulse than the hole current flowing into the N+ type semiconductor region **202**. In other examples, both the electron **402a** current and/or the **402b** hole current may be analyzed to determine the radiation absorbed.

As will be described in more detail below, the semiconductor volume of the detector **106** is designed/manufactured to mimic a specific biological cell or biological cell component. Biological cells from various tissues of the body differ from one another across a wide range of features and characteristics including, but not limited to, their size, shape, electrical conductivity, and LET values. Similarly, different biological cell components within a single cell also differ from one another across, among other things, their own size, shape, electrical conductivity, and LET values. Notably, the microdosimeters described herein feature detector cells that include semiconductor volumes that have at least one of a size, shape, electrical conductivity, and/or LET value(s) that approximately match the size, shape, electrical conductivity, and/or LET value(s) of a biological cell or biological cell component in order to reduce the RDCF needed and thus more accurately measure the actual radiation absorbed by the biological cell or cell component.

FIG. 5 illustrates a schematic, cross-sectional view of a human neutrophil white blood cell **500** according to one aspect. The white blood cell **500** is just one example of a biological cell that the detector **106** may be designed to mimic (e.g., size, shape, electrical conductivity, and/or LET value) in order to approximate the radiation absorbed by the biological cell. White blood cells are one of the body's cells that are most sensitive to radiation exposure, and neutrophils **500** account for about 50% to 70% of the total white blood cells in the human body. Among other organelles, a neutrophil white blood cell includes a nucleus **502** having genetic material **504**, golgi apparatus **506**, specific granules **508**, azurophil granules **510**, mitochondrion **512**, and endoplasmic reticulum **514**, all of which are suspended within the neutrophil's cytoplasm **516**. A typical neutrophil cell **500** is generally spherical and is about 12-15 μm in diameter. The neutrophil's components **502**, **504**, **506**, **508**, **510**, **512**, **514** may have various shapes and sizes, and are smaller than the neutrophil cell **500** itself. For example, the specific granules **508** and azurophil granules **510** may be generally spherical and have a diameter of about 1 μm . Mitochondrion typically have a length that is about 0.5 μm to 1.0 μm .

The electrical conductivity of the neutrophil cell **500** may vary depending the state of the immune system of the host (e.g., whether the immune system is responding to an

infection, toxin, etc.). Given a specific state of the immune system, the electrical conductivity of the neutrophil cell **500** and/or neutrophil cell's components **502**, **504**, **506**, **508**, **510**, **512**, **514** may be empirically collected and tabulated. Similarly, the LET values of the neutrophil cell **500** and/or its individual cell components **502**, **504**, **506**, **508**, **510**, **512**, **514** that are associated with various charged particles (e.g., alpha particles, protons, neutrons, beta particles, etc.) may also be empirically collected and tabulated.

According to one example, a detector **106** or a plurality of detectors **106** within a microdosimeter **100** may be designed/manufactured to mimic a neutrophil cell **500** and/or any one of the neutrophil cell components **502**, **504**, **506**, **508**, **510**, **512**, **514**. Specifically, at least one of the plurality of detectors **106** of the microdosimeter **100** may be fabricated so that at least one of its size, shape, electrical conductivity, and/or LET value(s) approximates that of a neutrophil cell **500** or component **502**, **504**, **506**, **508**, **510**, **512**, **514**.

For example, the width w , length l , and depth d of the detector's semiconductor volume (e.g., well **206**) may be sized so as to approximate the average dimensions and/or average volume of the neutrophil cell **500** (e.g., resulting in a substantially cube-shaped structure 12-15 μm across). As another example, the width w , length l , and depth d of the detector's semiconductor volume may be sized so as to approximate the average dimensions and/or average volume of any one of the neutrophil cell's components **502**, **504**, **506**, **508**, **510**, **512**, **514**. Of course, the width w , length l , and depth d of the detector's semiconductor volume may be sized so as to approximate the average dimensions and/or average volume of any biological cell type or biological cell component type.

Moreover, the detector's semiconductor volume (e.g., well **206**) may be fabricated such that its shape, at least in part, approximates the shape of the neutrophil cell **500**. For example, FIGS. 6 and 7 illustrate a detector **600** substantively similar in operation to the detector **106** of FIG. 1. For example, the detector **600** still comprises a heavily doped n-type first semiconductor region **602** and a heavily doped p-type second semiconductor region **604** formed within a p-type well **606**. However, the semiconductor volume (e.g., the p-type well **606**) of the detector **600** shown in FIGS. 6 and 7 has a semi-spherical shape (e.g., width w and length l are approximately equal and the depth d is $w/2$). That is, the semiconductor volume bounded by the planar, first surface (e.g., top surface) **702** and the curved, second surface **704** forms a semi-spherical shape. In this fashion, the detector **600** may approximate the shape of half of the neutrophil cell **500** or half of the neutrophil's components that also have spherical shapes (e.g., granules **508**, **510**). The other half of the neutrophil cell **500** or neutrophil component **508**, **510** may be approximated with another semi-spherical shaped detector within the microdosimeter **100**, which may have a plurality/array of detectors **106**, **600**. Generally, the detector's semiconductor volume may be fabricated such that its shape, at least in part, approximates the shape of any of the neutrophil's components **502**, **504**, **506**, **508**, **510**, **512**, **514**.

Furthermore, the detector's semiconductor volume may be fabricated with a semiconductor material having a particular doping concentration that approximates the conductivity of the neutrophil cell **500** or cell component **502**, **504**, **506**, **508**, **510**, **512**, **514**. For example, the semiconductor volume may be doped with various elements (e.g., phosphorus if the semiconductor volume is n-type, or boron if the semiconductor volume is p-type) to various degrees in order to replicate the conductivity of the neutrophil cell **500** or component **502**, **504**, **506**, **508**, **510**, **512**, **514**. Silicon may

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be doped to change its conductivity by over six orders of magnitude. For example, single-crystal silicon doped with phosphorus to a level of $10^{12}/\text{cm}^3$ may have a resistivity of approximately 25,000 $\Omega\text{-cm}$, which can be used to mimic the resistivity of cells or cell components that are as conductive as insulators (e.g., cortical bone cells). By contrast, doping the single-crystal silicon to $10^{19}/\text{cm}^3$ may provide a resistivity of about 0.01 $\Omega\text{-cm}$, which may be used to mimic cell components that are as conductive as common conductors (e.g., cell or cell components that are predominantly saline). Since most if not all cells, cell components (e.g., organelles), and tissues lie within this range of conductivity, the detector's **106** semiconductor volume (e.g., p-type well **206**) may be doped with, for example, boron to a doping concentration between the above given range. According to one aspect, the semiconductor volume's semiconductor doping type and concentration may be adjusted such that the first semiconductor volume has a conductivity that is configured to approximate within $\pm 5\%$, $\pm 10\%$, $\pm 15\%$, $\pm 20\%$, $\pm 25\%$, $\pm 30\%$, $\pm 35\%$, $\pm 40\%$, $\pm 45\%$, or $\pm 50\%$ of the conductivity of the first biological cell type or first biological cell component type that the microdosimeter cell's semiconductor volume is attempting to mimic.

For instance, in order to mimic the conductivity of a neutrophil cell **500**, which contains a moderate amount of ions and water, the boron doping concentration may be closer to higher end of the range (i.e., closer to the $10^{19}/\text{cm}^3$). The conductivity of the neutrophil components **502**, **504**, **506**, **508**, **510**, **512**, **514** may be similarly mimicked by varying the doping concentration of boron within the p-type well **206** of other detector **106** cells until the p-type well **206** conductivity matches the conductivity of a given cell component **502**, **504**, **506**, **508**, **510**, **512**, **514**.

Additionally, the detector's semiconductor volume may be fabricated using a semiconductor material and/or combination of materials that approximate the LET values (for one or more ionizing radiation particles) of the neutrophil cell **500** or cell component **502**, **504**, **506**, **508**, **510**, **512**, **514**. As discussed in greater detail below, some semiconductors, such as silicon and germanium, have LET value characteristics that closely match the LET value characteristics of different types of body tissues/cells. Therefore, germanium, silicon, and/or even carbon may be used to fabricate the semiconductor volume (e.g., p-type well **206**) of the detector **106** until its LET values closely match the LET values of the neutrophil cell **500** or cell component **502**, **504**, **506**, **508**, **510**, **512**, **514**.

As discussed above, the detector cell's **106** semiconductor volume may be sized, shaped, and fabricated (e.g., doping concentration and semiconductors used) to match the neutrophil cell **500** as a whole. Alternatively, the microdosimeter **100** comprising an array of detectors **106** (see FIG. 1) may have at least one detector that is sized, shaped, and fabricated to approximate each neutrophil component/organelle (e.g., golgi apparatus, mitochondrion, etc.) **502**, **504**, **506**, **508**, **510**, **512**, **514**. For example, one or more detectors **106** may be sized, shaped, and fabricated to match the size, shape, electrical conductivity, and/or LET values of the nucleus **502**, while another one or more detectors **106** may be sized, shaped, and fabricated to match the size, shape, electrical conductivity, and/or LET values of the mitochondrion **512**, and so on. In this fashion, the radiation exposure for the entire neutrophil cell **500** may be determined piecemeal by determining the radiation exposure to each cell component **502**, **504**, **506**, **508**, **510**, **512**, **514**. According to one aspect, the determined radiation exposure for each cell component **502**, **504**, **506**, **508**, **510**, **512**, **514** may be

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weighted with a sensitivity factor (e.g., indicative of the sensitivity to radiation and the importance of that component) and summed together to determine the final radiation exposure of the entire cell. Since the detector's **106** semiconductor volume may be fabricated smaller than 0.1 μm in diameter (e.g., width w and/or length l in FIG. 2), the radiation exposure of even the smallest cellular components of the neutrophil cell **500** may be approximated.

The discussion above related to designing/manufacturing the detector **106** to approximate the characteristics of a neutrophil cell **500** or its components **502**, **504**, **506**, **508**, **510**, **512**, **514** are merely examples. In practice any of the detectors described herein may be designed/manufactured so that their size, shape, electrical conductivity, LET values, and/or other characteristics that affect radiation absorption approximate the corresponding feature of a biological tissue, cell, or cell component (e.g., organelle). Such biological tissues, cells, and cell components are not limited to human tissues, cells, and cell components.

FIG. 8 illustrates an exemplary LET plot **800** that shows the energy transfer of a proton/hydrogen nuclei (e.g., one type of ionizing radiation) traveling through three types of semiconductors (e.g., carbon, silicon, and germanium), water, and cortical bone. On the vertical axis, the energy transfer is measured in kilo-electron-volt per micrometer ($\text{keV}/\mu\text{m}$), which translates to about 300 electron/hole pairs created within a given medium per μm of path length. As shown in the plot **800**, germanium absorbs a greater amount of radiation energy from a proton traveling through it per μm than silicon, which in turn absorbs a greater amount of radiation energy from a proton traveling through it per μm than carbon. Notably, it may be observed that germanium and cortical bone have very similar LET value characteristics compared to one another when the kinetic energy of the proton is less than about 300 keV. For example, for a proton having a kinetic energy of 100 keV, germanium and cortical bone have LET values that are within about 5% of each other. For a proton having a kinetic energy of 300 keV, germanium and cortical bone have LET values that are within about 15% of each other. Similarly, silicon and cortical bone have very similar LET value characteristics compared to one another when the kinetic energy of the proton is greater than about 300 keV. For example, for a proton having a kinetic energy of 1000 keV, silicon and cortical bone have LET values that are within 5% of each other. According to the plot **800** shown, carbon and water have very similar LET value characteristics as well. For example, for a proton having a kinetic energy between 100 and 100,000 keV, carbon and water have LET values that are within 8% of each other or less. Most biological tissues, cells, and cell components have LET value characteristics that lie in between these curves.

Consequently, germanium and/or silicon may be used to fabricate a detector's semiconductor volume (e.g., well, such as p-type well **206**) in cases where the detector is attempting to replicate the radiation absorption characteristics of bone tissue/cells, since bone tissue has a relatively high LET value compared to other tissues/cells. Similarly, carbon may be used, at least in part, to fabricate a detector's semiconductor volume (e.g., well, such as p-type well **206**) in cases where the detector is attempting to replicate the radiation absorption characteristics of a tissue, cell, or cell component that has a relatively low LET value compared to other tissues/cells. A detector's semiconductor volume may be fabricated using a combination of germanium, silicon, and/or carbon according to varying proportions to one another to replicate the LET value characteristics of various tissues,

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cells, or cell components that have LET values that lie between the LET values of carbon, silicon, and germanium.

FIG. 9 illustrates an example of an exemplary LET plot 900 that shows the energy transfer of protons traveling through silicon and skeletal muscle. The LET plot 900 shown is in units of electron-hole pairs generated per μm of path length. It may be observed that silicon and skeletal muscle have very similar LET value characteristics compared to one another for most proton kinetic energies. For example, for a proton having a kinetic energy of 100 keV, silicon and skeletal muscle have LET values that are within about 5% of each other. Thus, a detector's semiconductor volume fabricated using silicon is a close surrogate for skeletal muscle tissue.

FIG. 10 illustrates an example of an exemplary LET plot 1000 that shows the energy transfer of protons traveling through germanium and cortical bone. The LET plot 1000 shown is in units of electron-hole pairs generated per μm of path length. As described above, it may be observed that germanium and cortical bone have relatively similar LET value characteristics compared to one another for most proton kinetic energies. For example, for a proton having a kinetic energy of 100 keV, germanium and cortical bone have LET values that are within about 5% of each other. Thus, a detector's semiconductor volume fabricated using germanium is a close surrogate for cortical bone tissue.

Semiconductor alloys that combine carbon, silicon, germanium, and other elements provide a myriad of different types material that can be used to fabricate the semiconductor volume of any of the detectors described herein. Thus, any cell or cell component may be mimicked, in part, by selecting a specific semiconductor or combination of semiconductors/elements for a detector's semiconductor volume in order to best match the cell or cell component's LET value characteristics. According to one example, a semiconductor or combination of semiconductors may be used for a detector's semiconductor volume such that the semiconductor volume has an LET plot line that is within $\pm 5\%$, $\pm 10\%$, $\pm 15\%$, $\pm 20\%$, $\pm 25\%$, $\pm 30\%$, $\pm 35\%$, $\pm 40\%$, $\pm 45\%$, or $\pm 50\%$ of the LET values of the cell type being matched for protons having a kinetic energy between 10 keV and 100,000 keV.

The LET value characteristics in a detector's semiconductor volume may be dependent on many factors, including but not limited to: the atomic number of the atoms in the semiconductor volume; the atomic density of the semiconductor volume; the material conductivity of the semiconductor volume; the lattice structure of the semiconductor volume; and the presence of defects in the semiconductor volume. As such, in addition to the specific semiconductor used for the detector's semiconductor volume, any of the aforementioned factors may be varied in an attempt to mimic the LET value characteristics of a biological tissue, cell, or cell component.

Additional Exemplary Aspects of Microdosimeter

According to the example shown in FIGS. 2-4, the first semiconductor region 202 in the center of the detector 200 is n-type and the second semiconductor region 204 is p-type. However, in other aspects the first semiconductor region 202 may be a heavily doped p-type (i.e., P+ type) semiconductor region and the outer, second semiconductor region 204 may be a heavily doped n-type (i.e., N+ type) semiconductor region. An example of such a detector 1100 is shown in FIGS. 11 and 12.

Specifically, FIG. 11 illustrates a schematic top view of the detector 1100, and FIG. 12 shows a schematic cross-sectional view of the detector 1100 taken along the line

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12-12 shown in FIG. 11. Although the first semiconductor region 1102 and second semiconductor region 1104 have a doping type that is reversed with respect to the semiconductor regions 202, 204 of the detector 106, both detectors 106, 1100 may provide substantially similar performance.

The detectors described herein are not limited to any particular shape. For example, the detector 106 shown in FIGS. 2-4 have first and second semiconductor regions 202, 204 that are oval shaped. However, according to other aspects as described in part below, the first and second semiconductor regions 202, 204 may be rectangular, triangular, or have any other shape.

FIG. 13 illustrates a schematic top view of a detector 1300 according to one aspect. FIG. 14 illustrates a schematic cross-sectional view of the detector 1300 taken along the line 14-14 shown in FIG. 13. Unlike the oval detector 106 shown in FIG. 1, the detector 1300 shown in FIGS. 13 and 14 is rectangular in that the first and second semiconductor regions 1302, 1304 and the p-type well 1306 are concentric rectangles. The detector's semiconductor volume (e.g., p-type well 1306) has a width w , a length l , and a depth d . In one aspect, the width w and the length l are equal so that the detector 1300 is square cross-section. The detector 1300 operates in the same fashion described above with respect to the detector 106 shown in FIG. 1.

FIG. 15 illustrates a schematic top view of a radiation detector cell 1500 according to another aspect. FIG. 16 illustrates a schematic cross-sectional view of the detector cell 1500 taken along the line 16-16 of FIG. 15. Referring to FIGS. 15 and 16, the radiation detector cell 1500 is similar to the radiation detector cell 106 of FIGS. 2-4 except that the detector 1500 shown in FIG. 15 includes a third concentric ring-shaped semiconductor region 1506 that surrounds the first and second semiconductor regions 1502, 1504. The first, second, and third semiconductor regions 1502, 1504, 1506 reside within, for example, a p-type well 1508 (e.g., semiconductor volume). The third semiconductor region 1506 has the same doping type as the central, first semiconductor region 1502. In the illustrated example, the first and third semiconductor regions 1502, 1506 are P+ type, and the second semiconductor region 1504 is N+ type. However, in other aspects, the first and third semiconductor regions 1502, 1506 may be N+ type, and the second semiconductor region 1504 may be P+ type.

The detector 1500 operates in a somewhat similar fashion to the detector 106 of FIGS. 2-4. For example, incident radiation generates electron-hole pairs 1606a, 1606b within the semiconductor volume (e.g., p-type well 1508). If the first and third semiconductor regions 1502, 1506 are coupled to the supply voltage V_{DD} and the second semiconductor region 1504 is coupled to ground, an electric field (as illustrated by the dashed arrows) is created within the semiconductor volume 1508 that sweeps the electrons 1606a toward the P+ regions 1502, 1506 and the holes 1606b toward the N+ region 1504. These electrons 1606a and holes 1606b produce a current signal that can be measured and analyzed by a processing circuit (e.g., processing circuit 104 in FIG. 1) to determine the amount of radiation absorbed by the detector 1500.

Notably, the P+ type third semiconductor region 1506 "frames" the detector 1500 such that the electric field generated flows toward both sets of P+ regions 1502, 1506, and any current leakage that may otherwise flow out from the sides 1608 of the detector cell 1500 is reduced. The microdosimeter cell 1500 has a width w , a length l , and a depth d . According to one aspect, the width w and the length l may be equal so that the detector 1500 has a circular

cross-section. According to another aspect, the detector **1500** may have a semi-spherical shape such that the first surface (top surface) **1602** is planar (e.g., flat) and the second surface (bottom surface) **1604** is a semi-circular curve (i.e., similar to the detector **600** shown in FIG. 7). According to another aspect, the detector **1500** may be rectangular or square such as the detector **1300** shown in FIGS. 13 and 14.

According to one aspect, the detectors **106**, **600**, **1100**, **1300**, **1500** described above may be considered "planar" detectors in that the top surface **302**, **702**, **1202**, **1402**, **1602** that is exposed to the ionizing radiation is flat and/or level. According to other aspects the top surface may not be flat but instead have another three dimensional shape, such as a semi-spherical shape (e.g., similar to the second surface **704** in FIG. 7).

Exemplary Radiation Dosimeter

FIG. 17 illustrates a schematic block diagram of a radiation microdosimeter **1700** according to one aspect. The microdosimeter **1700** comprises a detector cell array **1702**, and may further comprise one or more processing circuits **1704**, one or more memory circuits **1706**, and one or more input/output (I/O) devices **1708**. The detector array **1702**, the processing circuit **1704**, the memory circuit **1706**, and the I/O devices **1708** may all communicate with one another via a bus **1709**.

Among other things, the processing circuit **1704** (e.g., processor) analyzes signals received from the detector array **1702** to determine the radiation levels detected by the detectors of the detector array **1702**. For example, the processing circuit **1704** may be configured to generate a signal based on a plurality of currents generated by a plurality of detectors **1710a**, **1710b**, . . . **1710n**, **1712a**, **1712b**, . . . **1712n**, **1714a**, **1714b**, . . . **1714n**, and the signal generated is indicative of an amount of radiation absorbed by the microdosimeter cell array **1702** and/or the radiation dosimeter **1700**. The memory circuit **1706** may include volatile and/or non-volatile memory that stores data and/or algorithms executed by the processing circuit **1704**. The I/O device **1708** may include, among other things, a display that indicates the level of radiation detected by the detector array **1702**.

According to one aspect, the detector array **1702** includes an integer number m detector cell groupings **1710**, **1712**, . . . **1714m**, where m is an integer greater than or equal to one (1). Each detector grouping includes an integer number n detector cells, where n is an integer greater than or equal to one (1). For example, a first detector grouping **1710** may include detectors **1710a**, **1710b**, . . . **1710n**, a second detector grouping **1712** may include detectors **1712a**, **1712b**, . . . **1712n**, and a third detector grouping may include detectors **1714a**, **1714b**, . . . **1714n**. The detectors **1710a**, **1710b**, . . . **1710n**, **1712a**, **1712b**, . . . **1712n**, **1714a**, **1714b**, . . . **1714n** may be, for example, any one of the detectors **106**, **600**, **1100**, **1300**, **1500**, **2400**, **2500**, **2600** shown in FIGS. 2-4, 6, 7, 11-16, 24, 25, and/or 26. In the example of FIG. 17, there are three detector groupings explicitly shown. However, the detector array **1702** may have any number of detector groupings, and each detector grouping may consist of any number (e.g., one, tens, hundreds, thousands, etc.) of individual detectors.

Each detector grouping **1710**, **1712**, . . . **1714m** may correspond to a particular cell type associated with a biological organism (e.g., a human) that is host to the various types of cell types mimicked by the detector groupings **1710**, **1712**, . . . **1714m**. For example, the first detector grouping **1710** that includes detectors **1710a**, **1710b**, . . . **1710n** may be fabricated to mimic one type of white blood cell of the

biological organism, such as neutrophil cell. The second detector grouping **1712** that includes detectors **1712a**, **1712b**, . . . **1712n** may be fabricated to mimic cortical bone cells of the biological organism. The third detector grouping **1714m** that includes detectors **1714a**, **1714b**, . . . **1714n** may be fabricated to mimic epithelial cells of the colon of the biological organism. Of course, the detector groupings **1710**, **1712**, **1714m** may include detectors that mimic other type of cells and/or cell components of the biological organism. Each of these detectors **1710a**, **1710b**, . . . **1710n**, **1712a**, **1712b**, . . . **1712n**, **1714a**, **1714b**, . . . **1714n** may be manufactured/designed to imitate properties of the biological cells and/or cell components they correspond to in order to better estimate the radiation absorbed by that particular cell or cell component type, and thus assess the general risk of bodily harm to the biological organism exposed to the radiation event. According to one aspect, the radiation measured/detected at each detector grouping **1710**, **1712**, . . . **1714m** may be separately tabulated and weighted by a relative radiation sensitivity scaling factor of that biological cell type. After weighting the current(s) generated by each detector grouping **1710**, **1712**, . . . **1714m** according to biological cell type, the results are summed to establish the composite radiation exposure for that biological organism represented by the plurality of detector groupings **1710**, **1712**, . . . **1714m** corresponding to the various biological cell types of the organism.

As one example, each detector grouping **1710**, **1712**, . . . **1714m** may correspond to a particular cell component/organelle type of a biological cell. For example, the detectors **1710a**, **1710b**, . . . **1710n** may be designed to mimic a mitochondrion of a neutrophil, the detectors **1712a**, **1712b**, . . . **1712n** may be designed to mimic a nucleus of a neutrophil, and the detectors **1714a**, **1714b**, . . . **1714n** may be designed to mimic a golgi apparatus of a neutrophil. Other cell groupings may each be designed to mimic other biological cell components/organelles of the neutrophil. According to one aspect, the radiation measured/detected at each detector grouping **1710**, **1712**, . . . **1714m** may be separately tabulated and weighted by a relative radiation sensitivity scaling factor of that biological cell component type. After weighting the current(s) generated by each detector grouping **1710**, **1712**, . . . **1714m** according to biological cell component type, the results are summed to establish the composite radiation exposure for that biological cell represented by the plurality of detector groupings **1710**, **1712**, . . . **1714m** corresponding to the various biological cell component types of the biological cell. Cell grouping also has significant practical benefits. For example, smaller groups have lower pulse pile-up and pickup noise, but also have lower sensitivity. Hence, one can match the group to the prevailing irradiation condition, thereby maximizing the accuracy of the measured response. Also, grouping can be used to select the desired sensitivity versus spatial resolution.

FIG. 18 illustrates a table **1800** that shows exemplary relative radiation sensitivity scaling factors (RRSSF) for various biological cell types associated with a biological organism (e.g., human) according to one aspect of the disclosure. In the example shown, the RRSSF for a neutrophil cell is 0.25, cortical bone cells is 0.05, skeletal muscle is 0.06, and epithelial cells of the colon is 0.28. These values are merely examples, and in practice any value consistent with laboratory experimentation of the actual relative radiation sensitivity of cells of the biological organism based on a specific type of radiation may be used. The RRSSF values may be based on the radiation sensitivity of the one bio-

logical cell type relative to (at least) the radiation sensitivity of another biological cell type of the organism. Thus, in the example described above, neutrophil cells are assumed to be five (5) times more sensitive to radiation than cortical bone cells. According to one aspect, the radiation dosimeter's 1700 processing circuit 1704 is configured to generate a signal based on a first current generated at a first detector 1710a and a second current generated at a second detector 1712a. The signal generated may be based on the first current weighted by a first relative radiation sensitivity scaling factor and the second current weighted by a second relative radiation sensitivity scaling factor, where the first relative radiation sensitivity scaling factor is based on radiation sensitivity of the first biological cell type relative to at least radiation sensitivity of the second biological cell type, and the second relative radiation sensitivity scaling factor is based on radiation sensitivity of the second biological cell type relative to at least radiation sensitivity of the first biological cell type.

FIG. 19 illustrates another table 1900 that shows exemplary relative radiation sensitivity scaling factors (RRSSF) for various biological cell component/organelle types associated with a biological cell (e.g., neutrophil cell) according to one aspect of the disclosure. In the example shown, the RRSSF for a mitochondrion is 0.10, a golgi apparatus is 0.08, a nucleus is 0.40, and a specific granule is 0.03. These values are merely examples, and in practice any value consistent with laboratory experimentation of the actual relative radiation sensitivity of the cellular components of the biological cell based on a specific type of radiation may be used. The RRSSF values may be based on the radiation sensitivity of the one biological cell component type relative to (at least) the radiation sensitivity of another biological cell component type of the biological cell. Thus, in the example described above, the cell nucleus is assumed to be five (5) times more sensitive to radiation than the golgi apparatus. According to one aspect, the radiation dosimeter's 1700 processing circuit 1704 is configured to generate a signal based on a first current generated at a first detector 1710a and a second current generated at a second detector 1712a. The signal generated may be based on the first current weighted by a first relative radiation sensitivity scaling factor and the second current weighted by a second relative radiation sensitivity scaling factor, where the first relative radiation sensitivity scaling factor is based on radiation sensitivity of the first biological cell component type relative to at least radiation sensitivity of the second biological cell component type, and the second relative radiation sensitivity scaling factor is based on radiation sensitivity of the second biological cell component type relative to at least radiation sensitivity of the first biological cell component type.

Referring back to FIG. 17, according to one aspect, each detector within a detector grouping 1710, 1712, . . . 1714m may be sized and/or shaped to match the biological cell type or biological cell component to which it corresponds. For example, the detectors 1710a, 1710b, . . . 1710n that correspond to neutrophils may have a width w and length l equal to 13.5 μm , which is approximately the diameter of a neutrophil cell (see e.g., FIG. 5). Similarly, the detector depth d can also be made to correlate with the biological cell or cell component depth. As another example, the detectors 1712a, 1712b, . . . 1712n of the second group 1712 may correspond to the nucleus of the neutrophil and may thus have a device width w, length l, and depth d that is smaller. In other aspects, the detector width w, length l, and/or depth d may be equal to the diameter of the biological cell or cell

component being mimicked multiplied by an adjustment factor, for example, between 0.5 and 4.0.

According to one aspect, each detector within a detector group 1710, 1712, . . . 1714m may have a semiconductor volume that is composed of a semiconductor material having LET value characteristics that match the LET value characteristics of the biological cell or cell component that detector is attempting to mimic. For example, the semiconductor volumes of the detectors 1710a, 1710b, 1710n may be composed of silicon if the detectors 1710a, 1710b, . . . 1710n are mimicking skeletal muscle cells. Similarly, the semiconductor volumes of the detectors 1710a, 1710b, . . . 1710n may be composed of germanium if the detectors 1710a, 1710b, 1710n are mimicking cortical bone cells.

According to another aspect, silicon may be used as the semiconductor volume regardless of the specific type of biological cell or cell component the detector is trying to mimic in order to save on manufacturing costs and complexity. In such a case, a correction factor may be applied, for example between 0.1 and 3.0 to match the LET characteristics of the silicon semiconductor volume to the biological cell or cell component material being mimicked. In most cases however, the energy deposited by high energy ions in tissue is almost always within a factor of two of that in silicon. An additional correction may also be applied for density changes between that of silicon and the specific biological cell or cell component being mimicked to keep the induced error within a factor of two.

According to one aspect, a possible simplification for some microdosimeters would be to use one detector shape (e.g., a semiconductor volume having a spherical shape (i.e., first surface 302, 702, 1202, 1402, 1602 is curved) or a planar circle, oval, rectangle, etc.) and/or size (e.g., width w, length l, and/or depth d equal to about 1 μm) to mimic the various types of cell granules within a cell. Since granules are believed to be a relatively insensitive component of biological cells, some inaccuracy in approximating the actual radiation absorbed by the granules would not significantly impact an assessment of the comprehensive bodily radiation threat analysis.

According to one aspect, the detectors 106, 600, 1100, 1300, 1500 may be planar as shown in FIGS. 2-4, 6, 7, and 11-16. That is, the semiconductor volumes of these detectors have a flat, planar top surface 302, 702, 1202, 1402, 1602. According to another aspect, detectors may be formed that closely approximate the actual, non-planar shape of the biological cell or cell component they attempt to mimic. For example, the semiconductor volume of a detector may be shaped such that it resembles a red blood cell (e.g., concave or biconcave disk) or a mitochondrion (e.g., capsule shaped) of a neutrophil. As one example, three dimensional (3D) printing processes using a semiconductor (e.g., silicon, carbon, germanium, etc.) as a deposition material may be used to form the non-planar detectors having the biological cell or cell component-specific shapes, such as, but not limited to ovals, spheres, rods, triangular prisms, rectangular prisms, etc. Such detectors may have a polycrystalline semiconductor volume. However, according to some applications planar detectors 106, 600, 1100, 1300, 1500 may be preferred due to manufacturing ease and budgetary constraints.

According to another aspect, the semiconductor material comprising the semiconductor volume of the detectors 106, 600, 1100, 1300, 1500 may be doped with various elements (e.g., phosphorus if the semiconductor volume is n-type, or boron if the semiconductor volume is p-type) to various degrees in order to replicate the conductivity of the biological

cal cell or cell component that the detector **106, 600, 1100, 1300, 1500** is attempting to mimic. As discussed above, silicon may be doped to change its conductivity by over six orders of magnitude. For example, single-crystal silicon doped with phosphorus to a level of $10^{12}/\text{cm}^3$ may have a resistivity of approximately 25,000 $\Omega\text{-cm}$, which can be used to mimic the resistivity of biological cells or cell components that are as conductive as insulators (e.g., cortical bone cells). By contrast, doping the single-crystal silicon to $10^{19}/\text{cm}^3$ may provide a resistivity of about 0.01 $\Omega\text{-cm}$, which may be used to mimic biological cells or cell components that are as conductive as common conductors (e.g., biological cell or cell components that are predominantly saline). A vast majority of cells, cell components, and tissues lie within this range of conductivity.

According to another aspect, the semiconductor material comprising the semiconductor volume of the detectors **106, 600, 1100, 1300, 1500** may use a specific type of semiconductor to further approximate the radiation absorption characteristics (e.g., LET characteristics) of the biological cell or cell component that the detector **106, 600, 1100, 1300, 1500** is attempting to mimic. For example, a high band-gap semiconductor may be used for insulating cells such as bone, and low band-gap semiconductors may be used for conducting cells such as gastro-intestinal cells.

According to yet another aspect, a detector grouping **1710, 1712, . . . 1714m** that mimics biological cells that are near the body's surface (e.g., cells underneath the skin) may be covered with a radiation absorption layer, such as a few millimeters of polyethylene or another hydrocarbon, in order to mimic the radiation absorption properties of skin.

According to another aspect, the detectors **106, 600, 1100, 1300, 1500** may be encased or covered by a tissue equivalent medium to better approximate the radiation reaching the biological cell or cell component that the detector array **1702** mimics. The tissue equivalent medium generates secondary charged particles that may also be detected and measured by the semiconductor volumes of the detectors **106, 600, 1100, 1300, 1500**.

Thus, according to one aspect, the radiation dosimeter **1700** comprises a microdosimeter cell array **1702** including a first microdosimeter cell **1710a** having a first semiconductor volume (e.g., any of the semiconductor volumes **206, 606, 1306, 1508** described above) configured to generate a first current in response to incident radiation. The first semiconductor volume may have at least one of a first size, a first shape, a first semiconductor type, and/or a first semiconductor doping type and concentration that is associated with a first biological cell type or a first biological cell component type. The radiation dosimeter further comprises a processing circuit **1704** communicatively coupled to the microdosimeter cell array **1702** and configured to generate a signal based on the first current, where the signal is indicative of an amount of radiation absorbed by the microdosimeter cell array **1702**.

The microdosimeter cell array **1702** may further include a second microdosimeter cell **1712a** that has a second semiconductor volume (e.g., any of the semiconductor volumes **206, 606, 1306, 1508** described above) configured to generate a second current in response to the incident radiation. The second semiconductor volume may have at least one of a second size, a second shape, a second semiconductor type, and/or a second semiconductor doping type and concentration that is associated with a second biological cell type or a second biological cell component type, and where and at least one of (a) the first size is different than the second size, (b) the first shape is different than the second

shape, (c) the first semiconductor type is different than the second semiconductor type, and/or (d) the first semiconductor doping type and concentration is different than the second semiconductor doping type and concentration. The signal generated by the processing circuit may be further based on the second current.

The microdosimeter cell array **1702** may further include a third microdosimeter cell having a third semiconductor volume (e.g., any of the semiconductor volumes **206, 606, 1306, 1508** described above) configured to generate a third current in response to the incident radiation. The third semiconductor volume may have at least one of a third size, a third shape, a third semiconductor type, and/or a third semiconductor doping type and concentration that is associated with a third biological cell type or a third biological cell component type, and where at least one of (a) the second size is different than the third size, (b) the second shape is different than the third shape, (c) the second semiconductor type is different than the third semiconductor type, and/or (d) the second semiconductor doping type and concentration is different than the third semiconductor doping type and concentration. The signal generated by the processing circuit may be further based on the third current.

According to another aspect, the radiation dosimeter **1700** comprises a first microdosimeter cell **1710a** that includes a first semiconductor volume (e.g., any of the semiconductor volumes **206, 606, 1306, 1508** described above), a first cell first semiconductor region (e.g., any of the first semiconductor regions **202, 602, 1102, 1302, 1502** described above), and a first cell second semiconductor region (e.g., any of the second semiconductor regions **204, 604, 1104, 1304, 1504** described above). The first semiconductor volume may be configured to generate a first current in response to radiation incident upon the radiation dosimeter, where the first current is configured to flow between the first cell first semiconductor region and the first cell second semiconductor region. The first microdosimeter cell may include a first size, a first semiconductor type, and/or a first semiconductor doping type and concentration that is based on a first biological cell type or a first biological cell organelle type. The radiation dosimeter **1700** may further comprise a processing circuit **1704** communicatively coupled to the first microdosimeter cell **1710a** and configured to generate a signal based on the first current. The signal may be indicative an amount of the radiation absorbed the radiation dosimeter. The dosimeter **1700** may further comprise a display **1710** communicatively coupled to the processing circuit and configured to display a radiation level reading based on the signal generated.

The radiation dosimeter **1700** may further comprise a second microdosimeter cell **1712a** including a second semiconductor volume (e.g., any of the semiconductor volumes **206, 606, 1306, 1508** described above), a second cell first semiconductor region (e.g., any of the first semiconductor regions **202, 602, 1102, 1302, 1502** described above), and a second cell second semiconductor region (e.g., any of the second semiconductor regions **204, 604, 1104, 1304, 1504** described above). The second semiconductor volume may be configured to generate a second current in response to the radiation incident upon the radiation dosimeter, and the second current is configured to flow between the second cell first semiconductor region and the second cell second semiconductor region. The second microdosimeter cell includes a second size, a second semiconductor type, and/or a second semiconductor doping type and concentration that is based on a second biological cell type or a second biological cell organelle type, and at least one of (a) the first size is different than the second size, (b) the first semiconductor type is

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different than the second semiconductor type, and/or (c) the first semiconductor doping type and concentration is different than the second semiconductor doping type and concentration, and wherein the signal generated by the processing circuit is further based on the second current.

Exemplary Method

FIG. 20 illustrates a flow chart 2000 of an exemplary method according to one aspect of the disclosure. First, a first microdosimeter cell is provided having a first semiconductor volume configured to generate a first current in response to incident radiation 2002. Next, the first semiconductor volume is formed such that the first semiconductor volume has at least one of a first size, a first shape, a first semiconductor type, and/or a first semiconductor doping type and concentration that is associated with a first biological cell type or a first biological cell component type 2004. Then, a processing circuit is coupled to the first microdosimeter cell, where the processing circuit is configured to generate a signal based on the first current, and the signal is indicative of an amount of radiation absorbed by the first microdosimeter cell 2006.

According to one aspect, the method further comprises: providing a second microdosimeter cell having a second semiconductor volume configured to generate a second current in response to the incident radiation; forming the second semiconductor volume such that the second semiconductor volume has at least one of a second size, a second shape, a second semiconductor type, and/or a second semiconductor doping type and concentration that is associated with a second biological cell type or a second biological cell component type, and at least one of (a) the first size is different than the second size, (b) the first shape is different than the second shape, (c) the first semiconductor type is different than the second semiconductor type, and/or (d) the first semiconductor doping type and concentration is different than the second semiconductor doping type and concentration; and coupling the second microdosimeter cell to the processing circuit, the processing circuit further configured to generate the signal also based on the second current, the signal indicative of an amount of radiation absorbed by the first and second microdosimeter cells.

Wearable Devices and Microdosimeters that Detect Radiation Harmful to the Human Eye

As described above, microdosimeters may have semiconductor volumes that can be sized, shaped, doped, and include semiconductor materials that all attempt to mimic a specific biological cell or cell component. The human eye has a myriad of cell types and some of them are particularly sensitive to radiation. For example, one such cell type is the epithelial cells of the eye's lens, which as described above, are especially prone and sensitive to radiation. Any of the microdosimeters described above can include semiconductor volumes that: are sized and/or shaped to mimic one or more cells of the eye including the eye lens epithelial cells; include one or more semiconductor materials that mimics the LET characteristics of one or more cells of the eye including the eye lens epithelial cells; and/or have a doping type and/or concentration that mimics the electrical resistance of one or more cells of the eye including the eye lens epithelial cells.

FIG. 24 illustrates an exemplary microdosimeter cell 2400 that may be fabricated having a silicon-on-insulator (SOI) structure and also an approximate size and/or shape of an eye lens epithelial cell. Since lens epithelial cell size varies naturally (e.g., 8-21 μm in lateral dimensions and around 5-10 μm in depth), a plurality of microdosimeter cells 2400 each having lateral sizes (i.e., width and/or

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length) ranging, for example, from 12-15 μm and a depth of 5-15 μm may be grouped together in a microdosimeter cell array (not shown in FIG. 24). As one non-limiting, non-exclusive example, an array of 5,000 microdosimeter cells replicating lens epithelial cells could be fabricated on a single integrated circuit ("chip") that measures about 4x4 mm square. This would sample incident radiation in a lateral area comparable to the lens of an eye. In one aspect, the array could include a variety of microdosimeter cells of different sizes, shapes, electrical resistance, and/or LET characteristics that are representative of (e.g., mimic) the various cell types and/or cell components found in a human eye lens or human eye. Examples of such cells include lens epithelial cells, cornea epithelial cells, lens cortex with fiber cells, etc.

Referring to FIG. 25, in cases where very low radiation levels need to be detected, a "Mesa" cross-section microdosimeter can be constructed using integrated circuit technology. A microdosimeter cell 2500 having the "mesa" structure may be capable of detecting very low energy radiation that can still damage the lens epithelial cells. Like the other microdosimeters described herein, the microdosimeter cell 2500 may have a size (e.g., width w and length (perpendicular to w) that attempts to mimic the size of a human eye cell such as, but not limited to, lens epithelial cells. The microdosimeter cell 2500 may also have a semiconductor volume 2502 (intrinsic semiconductor, such as silicon) that approximates the volume of a cell of the human eye such as a lens epithelial cell.

Note that using integrated circuit technology, the epithelial cells can be replicated in most dimensions, however the minor edge roughness of the human epithelial cells probably would not be copied in detail since internal sharp edges to the microdosimeter cells might cause electric field breakdowns. Notwithstanding, a microdosimeter array may contain microdosimeter cells of many different sizes and shapes and fit together very much like a group of lens epithelial cells, and therefore achieve a very clear duplication of the human lens structure. Microdosimeters that have structures (e.g., semiconductor volumes) that mimic (e.g., matching the size, shape, resistance, radiation absorption characteristics, etc.) lens epithelial cells may be herein referred to as Lens Epithelial Cell Detectors (LECD).

In order to obtain maximum sensitivity, LECDs may be fabricated using Silicon-on-Insulator (SOI) technology. After completion of the microdosimeter cell arrays, the removal of the SOI silicon substrate has several advantages. First, the sensitive semiconductor volume of the microdosimeter cells can be made with all of the 3D dimensions of epithelial cells. Second, the microdosimeter can be laterally backfilled with any tissue equivalent material to make the response of the device more similar to that of tissue. In addition, other materials may be added to the backfill to change the sensitivity of the microdosimeter to certain radiations (e.g., B-10, U-235 to increase the sensitivity to thermal neutrons, Cd to decrease the sensitivity to thermal neutrons).

Third, by not backfilling the removed silicon substrate, the "bare" microdosimeter closely mimics the layer of epithelium cells on the surface of the eye. This is especially important for low energy radiation that is attenuated strongly within the first few millimeters of tissue.

Various approaches have been used successfully to remove the silicon substrate of a SOI integrated circuit array including chemical etching, laser ablation, mechanical polishing, and plasma etching. However, attempts at removing completely the silicon substrate in SOI devices have proved

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mostly to be unsuccessful, as the devices tend to buckle and crack as a result of inherent or polishing-induced stresses in the chip once the silicon substrate thickness is less than about 50 μm .

The below technology has applied the etching process to the complete removal of the silicon substrate in SOI devices without any attendant wafer cracking. The procedure is to cover the top and sides of the chips with the final packaging materials, and then covering these with photoresist or equivalent. The package is then placed in a XeF_2 atmosphere for etching the bulk Si; the package with the hole acting as a mask. Etching proceeds in a series of steps where a fraction of the silicon is removed during each step. Since XeF_2 exposure preferentially etches silicon over SiO_2 by a ratio of 1000:1, the etching steps continue until all the silicon is removed, with the buried oxide of the SOI layer acting as an effective etch stop.

FIG. 26 illustrates schematically an SOI microdosimeter 2600 resulting from the above process. The microdosimeter integrated circuit 2602 having the microdosimeter cell array is mounted on an integrated circuit carrier package 2604 with electrical connectors 2606. Internal connectors 2608 may be applied to connect the mounted integrated circuit 2602 to the carrier package 2604. Then a surface seal 2610, such as a tissue equivalent material, may be placed over the integrated circuit 2602. At the bottom of the mounting package 2604 is a hole 2612 to allow XeF_2 gas to penetrate toward the underside of the microdosimeter integrated circuit 2602. The XeF_2 etches the bottom layer of semiconductor substrate 2614, until it reaches the SiO_2 layer 2616 where the etching effectively stops. The etching forms a cavity 2618 exposing the SiO_2 layer 2616 and thus minimizing the amount of undesirable material separating the microdosimeter cell array located on the integrated circuit 2602 that can block or absorb incident radiation. According to one aspect, the cavity 2618 and hole 2612 may be filled (e.g., back-filled) with a tissue-equivalent material. The tissue-equivalent material filled into the cavity 2618 and hole 2612 may mimic the environment, such as an organ, that the biological cells being replicated by the microdosimeter array would ordinarily be situated in. Wearable Device Radiation Detector Having Eye Cell Mimicking Microdosimeters

FIG. 27 illustrates a wearable device 2700 that detects radiation according to one aspect of the disclosure. The wearable device 2700 may be, for example, a head-mounted wearable device such as, but not limited to, eye glasses to be worn on a user's (operator's) face. The wearable device 2700 includes radiation detectors that are particularly suited at measuring and reporting radiation that may be harmful to a user's eyes.

The wearable device 2700 may include a frame 2702 (e.g., eye-glass frame), which may include temples 2704, 2706, rims (eyewires) 2708, 2710, and/or a bridge 2712 coupling the rims 2708, 2710. Notably, the wearable device 2700 (e.g., the frame 2702) includes one or more radiation detectors 2714, 2715 that each include one or more of the microdosimeter arrays described herein. In the illustrated example, the radiation detectors 2714, 2715 are mounted onto one or more of the rims 2708, 2710 (e.g., front surface 2716 of the rims 2708, 2710) of the frame 2702 but in other aspects the one or more radiation detectors 2714, 2715 may be mounted on other portions of the wearable device 2700 such as, but not limited to, the temples 2704, 2706 and/or the bridge 2712. The radiation detectors 2714 and 2715 may be positioned as close to the user's eyes as possible without impeding the user's vision.

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The radiation detectors 2714, 2715 each include one or more microdosimeter cell arrays (e.g., array 1702 shown in FIG. 17) that include a plurality of microdosimeter cells. The microdosimeter cells are sized, shaped, and/or made with semiconductor materials and doping agents that mimic the size, shape, electrical resistance, and/or LET characteristics of one or more types of eye's cells such as, but not limited to, the eye lens epithelial cells. Thus, in one example, at least some of the microdosimeter cells in the microdosimeter array within the radiation detector(s) 2714, 2715 may have dimensions ranging in width and length of 9 μm to 17 μm and a depth of 5 to 15 μm in order to mimic the size and/or shape of lens epithelial cells. In some aspects, the lateral and/or depth dimensions of the microdosimeter cells within the radiation detectors 2714, 2715 mimicking eye lens epithelial cells may range from 4 μm to 100 μm . These microdosimeter cells may also include a semiconductor type (e.g., silicon, germanium, etc.) that mimics the LET characteristics of lens epithelial cells, and a semiconductor doping type and concentration that mimics the electrical resistance of lens epithelial cells. This allows the radiation detectors 2714, 2715 to detect and report radiation levels that may cause cataracts or other harm to the human eye.

According to one aspect, the radiation detector's 2714, 2715 microdosimeter cell arrays may be manufactured on SOI substrates, such as any of the ones shown and described with respect to FIGS. 24-26. This may allow the cell arrays to detect very low-energy radiation. In one example, the microdosimeter cell arrays of the detectors 2714, 2715 may contain 5,000 to 50,000 microdosimeter cells but in other examples fewer or more microdosimeters cells may be used. These microdosimeter cells may have differing characteristics (size, shape, electrical resistance, LET characteristics) that represent the eye lens' sensitive epithelial cells which might cause cataract effects to occur.

The radiation detectors 2714, 2715 may be communicatively coupled (e.g., direct electrical connection via wire) to other electronic components/devices/circuits on the wearable device 2700. For example, the wearable device 2700 may include a processing component 2718, a wireless communication interface 2720, a power source 2722, and various input and output (I/O) devices such as speakers 2724 (e.g., ear buds, bone conduction transducer, etc.), a microphone 2726, a display (not shown in FIG. 27), and/or a plurality of buttons (also not shown in FIG. 27). The processing component 2718 includes circuits (e.g., processing circuit 1704 and/or memory circuit 1706 shown in FIG. 17) that analyze the radiation levels detected by the radiation detectors 2714, 2715 (e.g., analyze the currents generated by the microdosimeter arrays 1702 within the radiation detectors 2714, 2715). The processing component 2718 may, for example, extract individual radiation detection events in the microdosimeter cells, typically with a readout of the entire microdosimeter cell array within a few microseconds. This allows sensitivity to individual events even with moderately high radiation levels.

The processing component 2718 may also transmit information pertaining to radiation ("radiation information") including radiation levels, exposure warnings, etc. to the user through the one or more output devices. For instance, the user may receive an audio warning through the ear buds 2724 that radiation levels have been detected that may be harmful to the user's eyes or a warning indicating that a system parameter of the wearable device 2700 has been changed. As another example, a display coupled to the frame 2702, such as a liquid crystal on silicon (LCoS) display, may be used to show the user the aforementioned information.

The processing component **2718** and/or the radiation detectors **2714**, **2715** may be communicatively coupled to the wireless communication interface **2720**. The wireless communication interface **2720** may include a short range (e.g., WiFi®, Bluetooth®, and other wireless local area network (WLAN) protocols) and/or a long range (e.g., wireless wide area network (WWAN), mobile cellular, etc.) wireless communication interface(s). For example, the interface **2720** may allow for communications to be transmitted and received to/from the wearable device **2700** and other electronic devices (not shown). The other electronic devices may be local or remotely located devices such as sensors, computers, servers, monitors, controllers, etc. The other electronic devices may set the wearable device's **2700** radiation detector thresholds or other parameters, and may have access to the radiation levels detected by the radiation detectors **2714**, **2715**. For example, the wireless communication interface **2720** may transmit the radiation information (e.g., radiation type, radiation levels, warnings, etc.) to a remote server where such data is monitored by other personnel and/or recorded.

According to one aspect, the wearable device **2700** and/or one of its electronic components **2714**, **2715**, **2718**, **2720** may include a global positioning system (GPS) module that receives location information. The processing component **2718** may then generate logs and/or tags that report radiation detection events with a location and time stamp. The power source **2722** (e.g., battery, solar cell panel, etc.) provides electrical power to the one or more electronic components **2714**, **2715**, **2718**, **2720**, **2724**, **2726** of the wearable device **2700**.

The user of the wearable device **2700** may interact with the wearable device **2700** in a variety of ways and reasons. For example, the user may need to be informed of the device's operational status, make changes in its operation, be alerted to any radiation dangers, and communicate to remote control and surveillance stations. The I/O devices and wireless communication interface **2720** of the wearable device **2700** allow the user to do that. The microphone **2726** may receive voice commands from the user that instruct it to: report back any radiation events detected and associated radiation levels; change radiation level threshold values that set off warnings; change various parameters of the device **2700**; and communicate with other electronic devices through the wireless communication interface **2720**.

In the example shown in FIG. **27**, the wearable device **2700** includes two radiation detectors **2714**, **2715**. However, in other aspects the wearable device **2700** may have more or less radiation detectors communicatively coupled to one or more processing components **2718**.

FIG. **28** illustrates a schematic block diagram of the wearable device **2700** according to one aspect of the disclosure. The wearable device **2700** may include the radiation detector **2714**, the processing component **2718**, the wireless communication interface **2720**, and I/O devices **2802**. These modules **2714**, **2718**, **2720**, **2802** may be communicatively couple to each other. For example, they may be communicatively coupled through a bus **2804**.

The processing component **2718** may include the processing circuit **1704** (e.g., one or more processors) and/or a memory circuit **1706** (e.g., one or more memory circuits) to process and/or store signals indicative of radiation received from the radiation detector **2714**. The processing component **2718** may also control the I/O devices **2802**, and control communications with other electronic devices through the wireless communication interface **2720**.

As described above, the radiation detector **2714** includes a microdosimeter array **1702** having a plurality of microdosimeter cells (any of the microdosimeters described herein). The microdosimeter cells may be sized, shaped, and/or made of semiconductor materials and doping agents that attempt to mimic the size, shape, electrical resistance, and/or LET characteristics of human eye cells or human eye cell components (e.g., nucleolus of a lens epithelial cell) so as to better approximate the radiation dose absorbed by a biological cell at issue. According to one aspect, the array **1702** includes one or more microdosimeter cells that mimic the lens epithelial cells. According to another aspect, the array **1702** also include one or more microdosimeter cells that mimic other types of eye cells.

The I/O devices **2802** allow a user to interact with the wearable device **2700**. It may, for example, include one or more speakers **2724** or bone conduction transducers, a microphone **2726**, a display **2806** (as described above), and/or one or more buttons **2808** (as described above).

It should be noted that the lens epithelial cells detector, described in this document, can be extended to other body organs with higher sensitivity to radiation than normal. For example, the thyroid gland in the human neck has been described as more than five times more sensitive to some kinds of radiation when exposed to external radiation, because it is a surface organ with little bodily absorption of radiation. A necklace or throat collar could be made, similar in design and function to the eyeglass wearable device described in detail here, in order to provide increased sensitivity to radiation by using microdosimeters (designed to mimic sensitive thyroid cells) placed in almost direct contact with the thyroid organ.

According to one aspect, the wearable device **2700** can accommodate additional sensor/readout modules for other tissues and organs. For example, other radiation detectors (like detectors **2714**, **2715**) may be located at different parts of the body and signals from such detectors indicative of radiation levels may be transmitted to the wearable device **2700** (e.g., processing component **2718**). For instance, examples include radiation detectors located at the extremities (foot and/or hand such as a ring), radiation detectors that mimic skin cells, and radiation detectors that mimic internal organs like the heart. According to another aspect, modules may be interface with the wearable device **2700** for non-ionizing radiation, such as UV, which can also cause cataracts and skin cancer. Other modules might include infrared (IR), laser light, and radiofrequency (RF).

According to yet another aspect, the wearable device **2700** can be extended to accommodate a network of sensors located remotely from the operator. For example, the sensors may utilize the microdosimeters as area monitors for surveillance of occupied or unoccupied areas. User can query the wearable device **2700**, "Where should I go to lower my exposure?" or "Where is the radiation source?"

According to one aspect, the analysis and display system can synthesize data from multiple modules and/or sensors to guide the operator regarding actual or potential radiation exposures and their mitigation. According to another aspect, by utilizing multiple arrays the microdosimeter sensitivity can be maximized while maintaining a wide dynamic range of event rates with minimal artifacts due to event rate effects (e.g., deadtime, pulse pileup effects, chance coincidence effects). Collimators may also be used to increase the directionality of the radiation detectors' response. This would allow monoscopic, stereoscopic, or higher dimensional triangulation techniques to find and localize radiation sources, and to estimate the size of distributed radiation

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sources. According to yet another aspect, stacking arrays of sensors utilizes coincidence and anti-coincidence techniques to determine, for example, whether a small event was due to an incident particle having low energy versus its trajectory just grazed the detector.

FIG. 29 illustrates a method of manufacturing a wearable device featuring one or more microdosimeter cell arrays according to one aspect. The method may include first obtaining 2902 at least one of a size of a human eye lens epithelial cell, a shape of the human eye lens epithelial cell, a conductivity of the human eye lens epithelial cell, and/or a linear energy transfer (LET) value of the human eye lens epithelial cell for a first type of radiation. Next, a first microdosimeter cell array including a plurality of microdosimeter cells is formed 2904 each having a semiconductor volume adapted to generate a current in response to incident radiation, the semiconductor volumes of each of the plurality of microdosimeter cells formed to have at least one of (a) a size approximating the size of the human eye lens epithelial cell, a shape approximating the shape of the human eye lens epithelial cell, a semiconductor type having an LET value for the first type of radiation that approximates the LET value of the human eye lens epithelial cell, and/or a semiconductor doping type and concentration having a conductivity that approximates the conductivity of the human eye lens epithelial cell. Then, a processing circuit may be provided 2906 adapted to generate a signal based on the currents generated by the semiconductor volumes of the first plurality of microdosimeter cells, the signal indicative of an amount of radiation absorbed by the first microdosimeter cell array. Next, the processing circuit may be communicatively coupled 2908 to the first microdosimeter cell array. Then, a frame may be coupled 2910 to the first microdosimeter cell array, the frame adapted to be worn on face of the human user.

One or more of the components, steps, features, and/or functions illustrated in FIGS. 1, 2, 3, 4, 5, 6, 7, 8, 9, 10, 11, 12, 13, 14, 15, 16, 17, 18, 19, 20, 24, 25, 26, 27, 28, and/or 29 may be rearranged and/or combined into a single component, step, feature or function or embodied in several components, steps, or functions. Additional elements, components, steps, and/or functions may also be added without departing from the invention.

Also, it is noted that the aspects of the present disclosure may be described as a process that is depicted as a flowchart, a flow diagram, a structure diagram, or a block diagram. Although a flowchart may describe the operations as a sequential process, many of the operations can be performed in parallel or concurrently. In addition, the order of the operations may be re-arranged. A process is terminated when its operations are completed. A process may correspond to a method, a function, a procedure, a subroutine, a subprogram, etc. When a process corresponds to a function, its termination corresponds to a return of the function to the calling function or the main function.

The various features of the invention described herein can be implemented in different systems without departing from the invention. It should be noted that the foregoing aspects of the disclosure are merely examples and are not to be construed as limiting the invention. The description of the aspects of the present disclosure is intended to be illustrative, and not to limit the scope of the claims. As such, the present teachings can be readily applied to other types of apparatuses and many alternatives, modifications, and variations will be apparent to those skilled in the art.

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What is claimed is:

1. A wearable device comprising:

a first microdosimeter cell array including at least a first microdosimeter cell and a second microdosimeter cell, the first microdosimeter cell having a first semiconductor volume adapted to generate a first current in response to incident radiation, the first semiconductor volume having at least one of

- (a) a first size approximating a size of a human eye cell,
- (b) a first shape approximating a shape of the human eye cell,
- (c) a first semiconductor doping type and concentration having an electrical conductivity that approximates an electrical conductivity of the human eye cell, and/or
- (d) a first semiconductor type having a linear energy transfer (LET) value for a first type of radiation that approximates an LET value of the human eye cell for the first type of radiation,

the second microdosimeter cell having a second semiconductor volume adapted to generate a second current in response to the incident radiation, the second semiconductor volume having at least one of

- (e) a second size approximating a size of a biological cell or cell component,
- (f) a second shape approximating a shape of the biological cell or cell component,
- (g) a second semiconductor doping type and concentration having an electrical conductivity that approximates an electrical conductivity of the biological cell or cell component, and/or
- (h) a second semiconductor type having an LET value for the first type of radiation that approximates an LET value of the biological cell or cell component for the first type of radiation, and

wherein the biological cell or cell component is different than the human eye cell and at least one of the second size is different than the first size, the second shape is different than the first shape, the second semiconductor type is different than the first semiconductor type, and/or the second semiconductor doping type and concentration is different than the first semiconductor doping type and concentration; and

a processing circuit communicatively coupled to the first microdosimeter cell array and adapted to generate a first signal based on the first current and the second current generated by the first and second semiconductor volumes, the first signal indicative of an amount of radiation absorbed by the first microdosimeter cell array.

2. The wearable device of claim 1, wherein the human eye cell is an epithelial cell of the human eye.

3. The wearable device of claim 1, further comprising: an output device communicatively coupled to the processing circuit, the output device adapted to output radiation information based on the first signal.

4. The wearable device of claim 3, wherein the radiation information provides at least one of an audible warning and/or visual warning that radiation levels have been detected that may cause cataracts and/or blindness to a user wearing the wearable device.

5. The wearable device of claim 1, further comprising: a frame adapted to couple to a human face, the first microdosimeter cell array coupled to the frame.

6. The wearable device of claim 5, wherein the frame is an eye glass frame.

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7. The wearable device of claim 6, wherein the first microdosimeter cell array is positioned on a first rim, a first temple, and/or a bridge of the frame between the first rim and a second rim.

8. The wearable device of claim 7, further comprising: 5
a second microdosimeter cell array coupled to at least one of the second rim and/or a second temple of the frame, the second microdosimeter cell array including a plurality of microdosimeter cells each having a semiconductor volume adapted to generate current in response to the incident radiation, the semiconductor volumes of each of the plurality of microdosimeter cells of the second microdosimeter cell array having at least one of the first size, the first shape, the first semiconductor doping type and concentration, and the first semiconductor type, and wherein the processing circuit is communicatively coupled to the second microdosimeter cell array and adapted to generate a second signal based on the current generated by the semiconductor volumes of the second plurality of microdosimeter cells, the second signal indicative of an amount of radiation absorbed by the second microdosimeter cell array. 10 15 20

9. The wearable device of claim 1, wherein the first microdosimeter cell array has a silicon on insulator (SOI) structure having at least a portion of a bottom silicon substrate layer under an insulator layer removed to form a cavity exposing the insulator layer. 25

10. The wearable device of claim 9, wherein the cavity is filled with a tissue equivalent material. 30

11. The wearable device of claim 1, further comprising: a microphone communicatively coupled to the processing circuit and adapted to receive voice commands that retrieve radiation information from the processing circuit, the radiation information indicative of the amount of radiation absorbed by the first microdosimeter cell array. 35

12. The wearable device of claim 1, further comprising: a wireless communication interface communicatively coupled to the processing circuit, the wireless communication interface adapted to transmit, to another device, a message that includes information indicative of the amount of radiation absorbed by the first microdosimeter cell array. 40

13. The wearable device of claim 1, wherein the first semiconductor volume and the second semiconductor volume each have a lateral dimension ranging from 4 μm to 100 μm . 45

14. A wearable device comprising:

a microdosimeter cell array including a first plurality of microdosimeter cells and a second plurality of microdosimeter cells, the first plurality of microdosimeter cells each having 50

a first semiconductor volume adapted to generate a first current in response to incident radiation, the first semiconductor volume of each of the first plurality of microdosimeter cells having a first size, a first shape, a first semiconductor type, a first semiconductor doping type, and a first semiconductor doping concentration, and the second plurality of microdosimeter cells each having 60

a second semiconductor volume adapted to generate a second current in response to incident radiation, the second semiconductor volume of each of the second plurality of microdosimeter cells having a second size, a second shape, a second semiconductor type, a second semiconductor doping type, and a second 65

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semiconductor doping concentration, wherein at least one of the second size is different than the first size, the second shape is different than the first shape, the second semiconductor type is different than the first semiconductor type, the second semiconductor doping type is different than the first semiconductor doping type, and/or the second semiconductor doping concentration is different than the first semiconductor doping concentration; and

a processing circuit communicatively coupled to the microdosimeter cell array and configured to generate a signal based on the first current and the second current, the signal indicative of an amount of radiation absorbed by the first plurality microdosimeter cells and the second plurality of microdosimeter cells.

15. The wearable device of claim 14, wherein the first plurality of microdosimeter cells are associated with a human eye cell such that at least one of the first size approximates a size of a human eye cell, the first shape approximates a shape of the human eye cell, the first semiconductor type has a linear energy transfer (LET) value for a first type of radiation that approximates an LET value of the human eye cell for the first type of radiation, and/or the first semiconductor doping type and the first semiconductor doping concentration causes the first semiconductor volume to have an electrical conductivity that approximates an electrical conductivity of the human eye cell.

16. The wearable device of claim 15, further comprising: an output device communicatively coupled to the processing circuit, the output device adapted to output at least one of an audio and/or visual warning indicating that radiation levels have been detected that may cause cataracts and/or blindness.

17. The wearable device of claim 15, wherein the human eye cell is an epithelial cell, and the wearable device further comprises:

a frame adapted to couple to a human face, the microdosimeter cell array coupled to the frame.

18. A method of manufacturing a wearable device, the method comprising:

obtaining a linear energy transfer (LET) value of a human eye lens epithelial cell for a first type of radiation;

determining a semiconductor type having an LET value for the first type of radiation that approximates the LET value of the human eye lens epithelial cell obtained;

forming a microdosimeter cell array including a plurality of microdosimeter cells each having a semiconductor volume adapted to generate a current in response to incident radiation, the semiconductor volumes of each of the plurality of microdosimeter cells formed with the semiconductor type determined to have the LET value for the first type of radiation that approximates the LET value of the human eye lens epithelial cell obtained; and

communicatively coupling a processing circuit to the microdosimeter cell array, the processing circuit adapted to generate a signal based on the current generated by the semiconductor volumes of the plurality of microdosimeter cells, the signal indicative of an amount of radiation absorbed by the microdosimeter cell array.

19. The method of claim 18, further comprising: coupling a frame to the microdosimeter cell array, the frame adapted to be worn on a human face.

20. The method of claim 18, further comprising: communicatively coupling an output device to the processing circuit, the output device adapted to output at

least one of an audio and/or visual warning indicating that radiation levels have been detected that may cause cataracts and/or blindness.

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